

## LMX2572LP 2-GHz Low Power Wideband RF Synthesizer With FSK Modulation

### 1 Features

- Output Frequency: 12.5 MHz to 2 GHz
- Low Power Consumption: 70 mA at 3.3-V Supply
- –124-dBc/Hz Phase Noise at 100-kHz Offset With 800-MHz Carrier
- PLL Figure of Merit: –232 dBc/Hz
- PLL Normalized 1/f Noise: –123.5 dBc/Hz
- 32-Bit Fractional-N Divider
- Remove Integer Boundary Spurs With Programmable Input Multiplier
- Synchronization of Output Phase Across Multiple Devices
- Support for Ramp and Chirp Functions
- Support for FSK Direct Digital Modulation
- Two Programmable Output Power Level Differential Outputs
- Fast VCO Calibration Speed: < 20  $\mu$ s
- Single 3-V to 3.5-V Power Supply

### 2 Applications

- Test and Measurement Equipment
- Digital 2-Way Radios
- Low Power Radio Communication Systems
- Satellite Communication
- Wireless Microphones
- Proprietary Wireless Connectivity
- MIMO
- High-Speed Data Converter Clocking

### 3 Description

The LMX2572LP is a low-power, high-performance wideband synthesizer that can generate one frequency from 12.5 MHz to 2 GHz without the use of an internal doubler. The PLL delivers excellent performance while consuming just 70 mA from a single 3.3-V supply.

For applications like digital mobile radio (DMR) and wireless microphones, the LMX2572LP supports FSK modulation. Discrete level FSK and pulse-shaping FSK are supported. Direct digital FSK modulation is achievable through programming or pins.

The LMX2572LP allows users to synchronize the output of multiple devices and also enables applications that need deterministic delay between input and output. The LMX2572LP provides an option to adjust the phase with fine granularity to account for delay mismatch on the board or within devices. A frequency ramp generator can synthesize up to two segments of ramp in an automatic ramp generation option or a manual option for maximum flexibility. The fast calibration algorithm allows the user to change frequencies faster than 20  $\mu$ s.

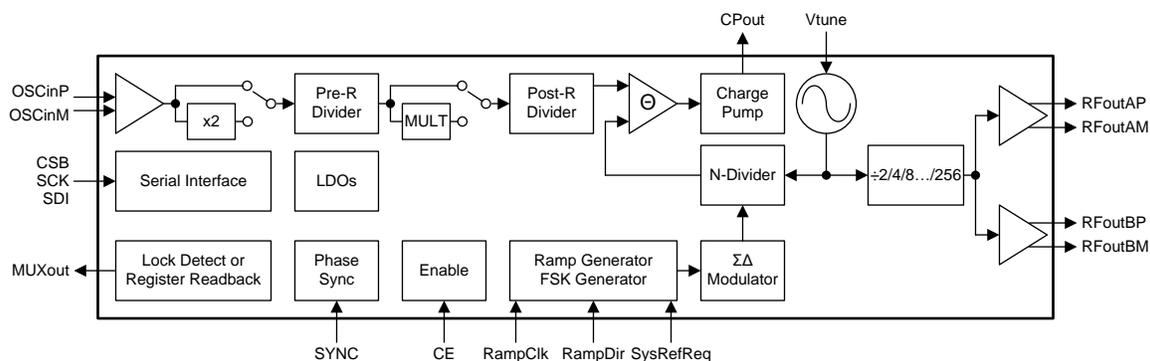
The LMX2572LP integrates LDOs from a single 3.3-V supply, thus eliminating the need for onboard low-noise LDOs.

#### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
LMX2572LP	VQFN (40)	6.00 mm x 6.00 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

#### Functional Block Diagram



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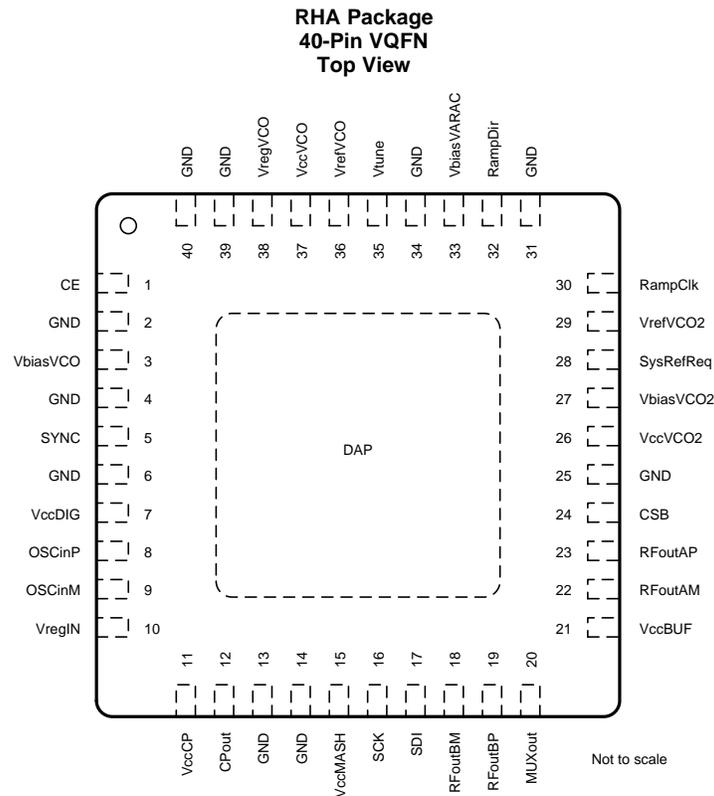
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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	VERSION	NOTES
May 2018	*	Initial Release

## 5 Pin Configuration and Functions



### Pin Functions

PIN		I/O	DESCRIPTION
NAME	NO.		
CE	1	Input	Chip enable. High impedance CMOS input. 1.8-V to 3.3-V logic. Active HIGH powers on the device.
CPout	12	Output	Charge pump output. Place C1 of loop filter close to this pin.
CSB	24	Input	SPI latch. High impedance CMOS input. 1.8-V to 3.3-V logic.
DAP	—	Ground	RF ground.
GND	2, 4, 25, 31, 34, 39	Ground	VCO ground.
	6, 14, 40	Ground	Digital ground.
	13	Ground	Charge pump ground.
MUXout	20	Output	Multiplexed output pin. Configurable between lock detect and register readback.
OSCinM	9	Input	Reference input clock (–). High impedance self-biasing pin. Requires AC-coupling.
OSCinP	8	Input	Reference input clock (+). High impedance self-biasing pin. Requires AC-coupling.
RampClk	30	Input	Ramp trigger in automatic ramping mode or ramp clock in manual ramping mode. Can also be used as FSK I2S clock input. High impedance CMOS input. 1.8-V to 3.3-V logic.
RampDir	32	Input	Ramp trigger in automatic ramping mode or ramp segment selection in manual ramping mode. Can also be used as FSK I2S data input. High impedance CMOS input. 1.8-V to 3.3-V logic.
RFoutAM	22	Output	Differential output A (–). Low impedance output. Requires AC-coupling.
RFoutAP	23	Output	Differential output A (+). Low impedance output. Requires AC-coupling.
RFoutBM	18	Output	Differential output B (–). Low impedance output. Requires AC-coupling.
RFoutBP	19	Output	Differential output B (+). Low impedance output. Requires AC-coupling.
SCK	16	Input	SPI clock. High impedance CMOS input. 1.8-V to 3.3-V logic.

**Pin Functions (continued)**

PIN		I/O	DESCRIPTION
NAME	NO.		
SDI	17	Input	SPI data. High impedance CMOS input. 1.8-V to 3.3-V logic.
SYNC	5	Input	Phase synchronization trigger. Configurable to accept CMOS input (1.8-V to 3.3-V logic) or differential input.
SysRefReq	28	Input	FSK I2S Frame Sync input. High impedance CMOS input. 1.8-V to 3.3-V logic.
VbiasVARAC	33	Bypass	VCO Varactor bias. Connect a 10- $\mu$ F decoupling capacitor to VCO ground.
VbiasVCO	3	Bypass	VCO bias. Connect a 470-nF (X7R) decoupling capacitor to VCO ground as close to this pin as possible.
VbiasVCO2	27	Bypass	VCO bias. Connect a 100-nF (X7R) decoupling capacitor to VCO ground.
VccBUF	21	Supply	Supply for output buffers. Connect a 0.1- $\mu$ F decoupling capacitor to RF ground.
VccCP	11	Supply	Supply for charge pump. Connect a 0.1- $\mu$ F decoupling capacitor to charge pump ground.
VccDIG	7	Supply	Digital power supply. Connect a 0.1- $\mu$ F decoupling capacitor to digital ground.
VccMASH	15	Supply	Digital power supply. Connect a 1- $\mu$ F decoupling capacitor to digital ground.
VccVCO	37	Supply	Supply for VCO. Connect a 1- $\mu$ F decoupling capacitor to VCO ground.
VccVCO2	26	Supply	Supply for VCO. Connect a 1- $\mu$ F decoupling capacitor to VCO ground.
VrefVCO	36	Bypass	VCO supply reference. Connect a 10- $\mu$ F decoupling capacitor to VCO ground.
VrefVCO2	29	Bypass	VCO supply reference. Connect a 10- $\mu$ F decoupling capacitor to VCO ground.
VregIN	10	Bypass	Input reference path regulator output. Connect a 1- $\mu$ F decoupling capacitor to RF ground as close to this pin as possible.
VregVCO	38	Bypass	VCO regulator node. Connect a 10-nF decoupling capacitor to VCO ground.
Vtune	35	Input	VCO tuning voltage input. Connect a 1.5-nF or more capacitor to VCO ground. See <a href="#">External Loop Filter</a> for details.

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
$V_{CC}$	Power supply voltage	-0.3	3.6	V
$V_{IN}$	IO input voltage		$V_{CC} + 0.3$	V
$T_J$	Junction temperature		150	°C
$T_{stg}$	Storage temperature	-65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Rating* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Condition*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

		VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	$\pm 2000$
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>	$\pm 500$

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
$T_A$	Ambient temperature	-40		85	°C
$T_J$	Junction temperature			125	°C

## 6.4 Thermal Information

THERMAL METRIC <sup>(1)</sup>		LMX2572LP	
		RHA (VQFN)	
		40 PINS	
			UNIT
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	25.5	°C/W
R <sub>θJC(top)</sub>	Junction-to-case (top) thermal resistance	14.4	°C/W
R <sub>θJB</sub>	Junction-to-board thermal resistance	8	°C/W
Ψ <sub>JT</sub>	Junction-to-top characterization parameter	0.2	°C/W
Ψ <sub>JB</sub>	Junction-to-board characterization parameter	7.9	°C/W
R <sub>θJC(bot)</sub>	Junction-to-case (bottom) thermal resistance	1.2	°C/W

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

3.0 V ≤ V<sub>CC</sub> ≤ 3.5 V, -40°C ≤ T<sub>A</sub> ≤ 85°C. Typical values are at V<sub>CC</sub> = 3.3 V, 25°C (unless otherwise noted).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>POWER SUPPLY</b>						
V <sub>CC</sub>	Supply voltage		3	3.3	3.5	V
I <sub>CC</sub>	Supply current	f <sub>OSCin</sub> = 20 MHz; f <sub>PD</sub> = 40 MHz <sup>(1)</sup>		70		mA
		f <sub>OSCin</sub> = 100 MHz; f <sub>PD</sub> = 100 MHz <sup>(2)</sup>		74.5		
I <sub>CCPD</sub>	Power down current			2.5		
<b>INPUT SIGNAL PATH</b>						
f <sub>OSCin</sub>	OSCin input frequency	OSC_2X = 0 (Doubler bypassed)	5		250	MHz
		OSC_2X = 1 (Doubler enabled)	5		125	
V <sub>OSCin</sub>	OSCin input voltage <sup>(3)</sup>	Single-ended input buffer	0.3		3.6	V
		Differential input buffer	0.15		1	
f <sub>MULTin</sub>	Multiplier input frequency	MULT ≥ 3	10		40	MHz
f <sub>MULTout</sub>	Multiplier output frequency		60		150	
<b>PLL</b>						
f <sub>PD</sub>	Phase detector frequency <sup>(4)</sup>	Integer channel	0.25		250	MHz
		1 <sup>st</sup> and 2 <sup>nd</sup> order modulator	5		200	
		3 <sup>rd</sup> order modulator	5		160	
		4 <sup>th</sup> order modulator	5		120	
I <sub>CPout</sub>	Charge pump current	CPG = 1		625		μA
		CPG = 2		1250		
		CPG = 3		1875		
		...		...		
		CPG = 15		6875		
PN <sub>PLL_1/f</sub>	Normalized PLL 1/f noise <sup>(5)</sup>			-123.5		dBc/Hz
PN <sub>PLL_Flat</sub>	Normalized PLL noise floor <sup>(5)</sup>	Integer channel <sup>(6)</sup>		-232		
		Fractional channel <sup>(7)</sup>		-232		
<b>VCO</b>						
f <sub>VCO</sub>	VCO frequency		3200		6400	MHz

(1) I<sub>CP</sub> = 2.5 mA; f<sub>VCO</sub> = 3.2 GHz; f<sub>OUT</sub> = 400 MHz; P<sub>OUT</sub> = -3 dBm; OSC\_2X = 1; MULT = 1; one RF output.

(2) I<sub>CP</sub> = 2.5 mA; f<sub>VCO</sub> = 3.2 GHz; f<sub>OUT</sub> = 400 MHz; P<sub>OUT</sub> = -3 dBm; OSC\_2X = 0; MULT = 1; one RF output.

(3) See [OSCin Configuration](#) for definition of OSCin input voltage.

(4) For lower VCO frequencies, the N-divider minimum value can limit the phase detector frequency.

(5) Measured with a clean OSCin signal with a high slew rate using a wide loop bandwidth. The noise metrics model the PLL noise for an infinite loop bandwidth as: PLL<sub>Total</sub> = 10\*log[10<sup>(PLL\_Flat/10)</sup> + 10<sup>(PLL\_Flicker/10)</sup>]; PLL<sub>Flat</sub> = PN1 Hz + 20\*log(N) + 10\*log(f<sub>PD</sub>); PLL<sub>Flicker</sub> = PN10 kHz - 10\*log(Offset/10 kHz) + 20\*log(f<sub>OUT</sub>/1 GHz)

(6) f<sub>OSCin</sub> = 200 MHz; f<sub>PD</sub> = 100 MHz; f<sub>VCO</sub> = 6 GHz

(7) f<sub>OSCin</sub> = 200 MHz; f<sub>PD</sub> = 100 MHz; f<sub>VCO</sub> = 6.001 GHz; Fractional denominator = 1000.

**Electrical Characteristics (continued)**

 3.0 V ≤ V<sub>CC</sub> ≤ 3.5 V, –40°C ≤ T<sub>A</sub> ≤ 85°C. Typical values are at V<sub>CC</sub> = 3.3 V, 25°C (unless otherwise noted).

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
PN <sub>VCO</sub>	Open loop VCO phase noise	f <sub>OUT</sub> = 425 MHz (f <sub>VCO</sub> = 3.4 GHz)	10 kHz		–106		dBc/Hz
			100 kHz		–129		
			1 MHz		–149		
			10 MHz		–153.5		
		f <sub>OUT</sub> = 487.5 MHz (f <sub>VCO</sub> = 3.9 GHz)	10 kHz		–105.5		
			100 kHz		–129		
			1 MHz		–149.5		
			10 MHz		–152.5		
		f <sub>OUT</sub> = 550 MHz (f <sub>VCO</sub> = 4.4 GHz)	10 kHz		–104.5		
			100 kHz		–129		
			1 MHz		–149		
			10 MHz		–153		
		f <sub>OUT</sub> = 612.5 MHz (f <sub>VCO</sub> = 4.9 GHz)	10 kHz		–103		
			100 kHz		–128		
			1 MHz		–148.5		
			10 MHz		–154		
		f <sub>OUT</sub> = 675 MHz (f <sub>VCO</sub> = 5.4 GHz)	10 kHz		–102.5		
			100 kHz		–127		
			1 MHz		–147.5		
			10 MHz		–154		
f <sub>OUT</sub> = 737.5 MHz (f <sub>VCO</sub> = 5.9 GHz)	10 kHz		–102				
	100 kHz		–126.5				
	1 MHz		–147				
	10 MHz		–153				
K <sub>VCO</sub>	VCO gain	f <sub>VCO</sub> = 3.4 GHz			39		MHz/V
		f <sub>VCO</sub> = 3.9 GHz			44		
		f <sub>VCO</sub> = 4.4 GHz			55		
		f <sub>VCO</sub> = 4.9 GHz			60		
		f <sub>VCO</sub> = 5.4 GHz			69		
		f <sub>VCO</sub> = 5.9 GHz			62		
t <sub>VCOcal</sub>	VCO calibration-time <sup>(8)</sup>	f <sub>OSCin</sub> = f <sub>PD</sub> = 100 MHz; Switch between 3.2 GHz and 6.4 GHz VCO frequency	No assist		130		μs
			Partial assist		50		
			Full assist		5		
ΔT <sub>CL</sub>	Allowable temperature drift <sup>(9)</sup>	VCO not being re-calibrated, –40°C ≤ T <sub>A</sub> ≤ 85°C				125	°C
<b>RF OUTPUT</b>							
f <sub>OUT</sub>	RF output frequency			12.5		2000	MHz
P <sub>OUT</sub>	Single-ended output power	f <sub>OUT</sub> = 2 GHz	OUT <sub>x_PWR</sub> = 15		5		dBm
H <sub>2OUT</sub>	Second harmonic	f <sub>OUT</sub> = 800 MHz			–33.5		
		f <sub>OUT</sub> = 400 MHz			–43		
H <sub>3OUT</sub>	Third harmonic	f <sub>OUT</sub> = 800 MHz			–10.5		
		f <sub>OUT</sub> = 400 GHz		–10			
t <sub>skewCH</sub>	Channel to channel skew	f <sub>OUT</sub> = 2 GHz			14		ps

 (8) See [VCO Calibration](#) for details.

(9) Not tested in production. Ensured by characterization. Allowable temperature drift refers to programming the device at an initial temperature and allowing this temperature to drift WITHOUT reprogramming the device, and still have the device stay at lock. This change could be up or down in temperature and the specification does not apply to temperatures that go outside the recommended operating temperatures of the device.

## Electrical Characteristics (continued)

3.0 V ≤ V<sub>CC</sub> ≤ 3.5 V, –40°C ≤ T<sub>A</sub> ≤ 85°C. Typical values are at V<sub>CC</sub> = 3.3 V, 25°C (unless otherwise noted).

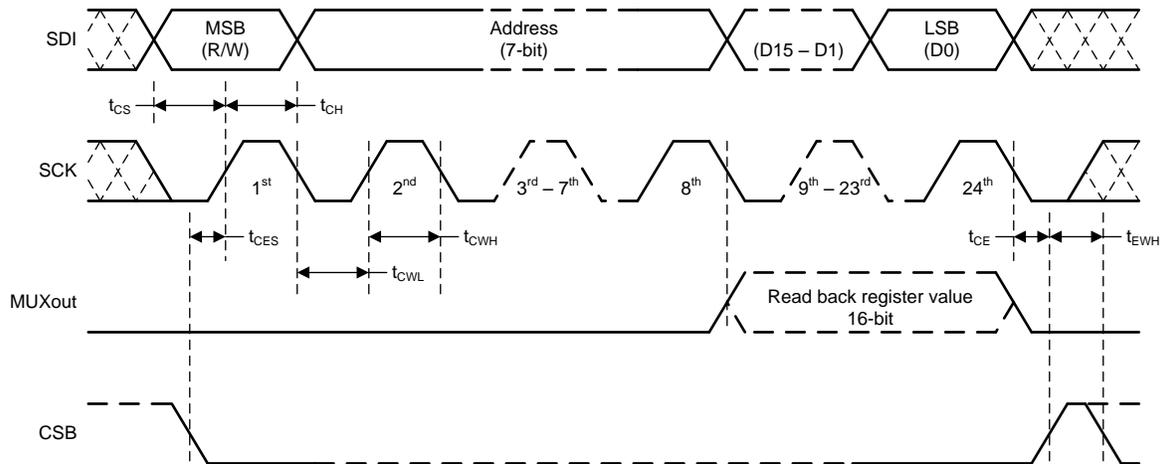
PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
<b>PHASE SYNCHRONIZATION</b>							
f <sub>OSCinSYNC</sub>	OSCin input frequency with SYNC	Category 3		5		100	MHz
		Categories 1 and 2		5		200	
t <sub>skewSYNC</sub>	OSCin to RFout skew	After phase synchronization; f <sub>OSCinSYNC</sub> = f <sub>OUT</sub> = 100 MHz			2		ns
<b>DIGITAL INTERFACE</b>							
V <sub>IH</sub>	High-level input voltage			1.4		V <sub>CC</sub>	V
V <sub>IL</sub>	Low-level input voltage					0.4	
I <sub>IH</sub>	High-level input current			–25		25	μA
I <sub>IL</sub>	Low-level input current			–25		25	
V <sub>OH</sub>	High-level output voltage	Load current = –5 mA	MUXout pin	V <sub>CC</sub> – 0.5			V
V <sub>OL</sub>	Low-level output voltage	Load current = 5 mA				0.5	

## 6.6 Timing Requirements

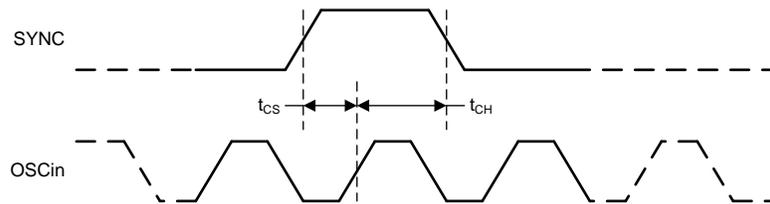
3.0 V ≤ V<sub>CC</sub> ≤ 3.5 V, –40°C ≤ T<sub>A</sub> ≤ 85°C. Typical values are at V<sub>CC</sub> = 3.3 V, 25°C (unless otherwise noted).

				MIN	NOM	MAX	UNIT
<b>SERIAL INTERFACE WRITE TIMING</b>							
f <sub>SCK</sub>	SCK frequency	1 / (t <sub>CWL</sub> + t <sub>CWH</sub> )				75	MHz
t <sub>ES</sub>	SCK to CSB low time	Figure 1		5			ns
t <sub>CS</sub>	SDI to SCK setup time			2			ns
t <sub>CH</sub>	SDI to SCK hold time			2			ns
t <sub>CWH</sub>	SCK pulse width high			5			ns
t <sub>CWL</sub>	SCK pulse width low			5			ns
t <sub>CES</sub>	CSB to SCK setup time			5			ns
t <sub>EWH</sub>	CSB pulse width high			2			ns
<b>SERIAL INTERFACE READ TIMING</b>							
f <sub>SCK</sub>	SCK frequency	1 / (t <sub>CWL</sub> + t <sub>CWH</sub> )				50	MHz
t <sub>ES</sub>	SCK to CSB low time	Figure 1		10			ns
t <sub>CS</sub>	SDI to SCK setup time			10			ns
t <sub>CH</sub>	SDI to SCK hold time			10			ns
t <sub>CWH</sub>	SCK pulse width high			10			ns
t <sub>CWL</sub>	SCK pulse width low			10			ns
t <sub>CES</sub>	CSB to SCK setup time			10			ns
t <sub>EWH</sub>	CSB pulse width high			10			ns
<b>SYNC TIMING</b>							
t <sub>CS</sub>	Pin to OSCin setup time	Figure 2		2.5			ns
t <sub>CH</sub>	Pin to OSCin hold time			2			ns

## 6.7 Timing Diagrams



**Figure 1. Serial Interface Timing Diagram**



**Figure 2. SYNC Timing Diagram**

## 6.8 Typical Characteristics

At  $T_A = 25^\circ\text{C}$ , unless otherwise noted

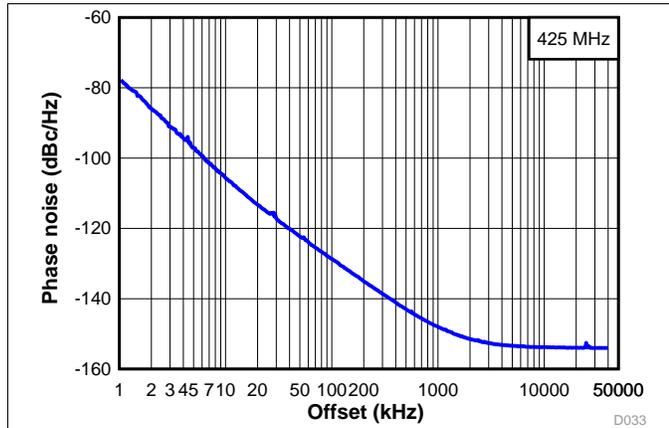


Figure 3. Open-Loop VCO Phase Noise at 425 MHz

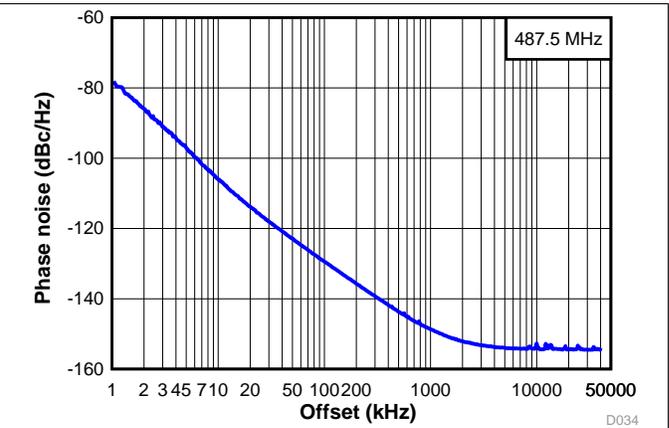


Figure 4. Open-Loop VCO Phase Noise at 487.5 MHz

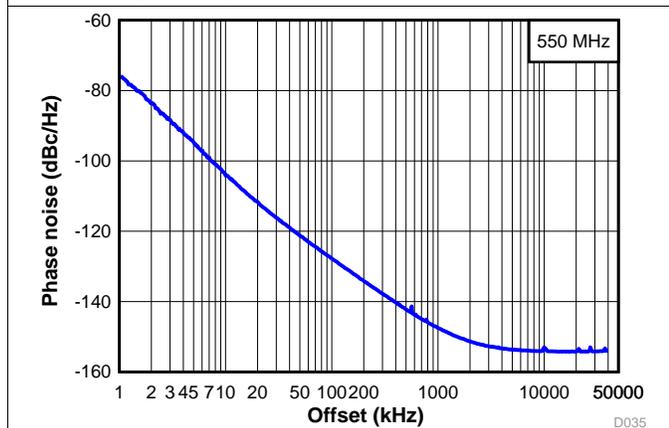


Figure 5. Open-Loop VCO Phase Noise at 550 MHz

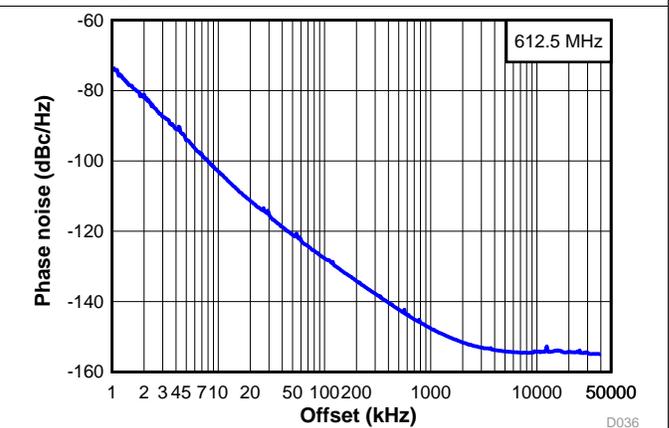


Figure 6. Open-Loop VCO Phase Noise at 612.5 MHz

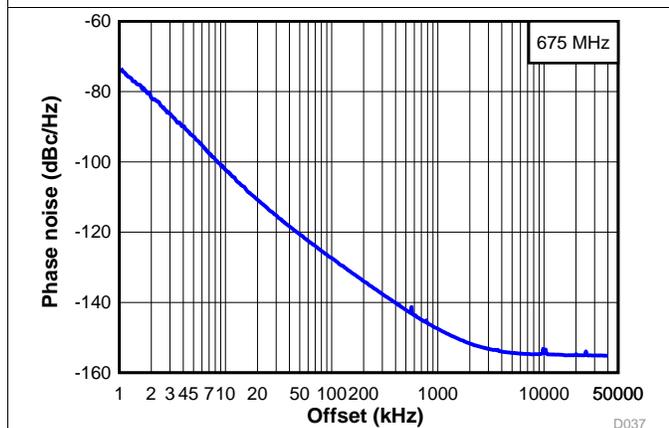


Figure 7. Open-Loop VCO Phase Noise at 675 MHz

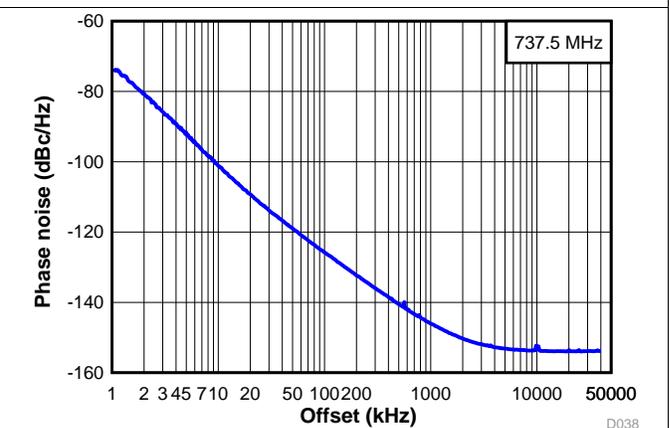
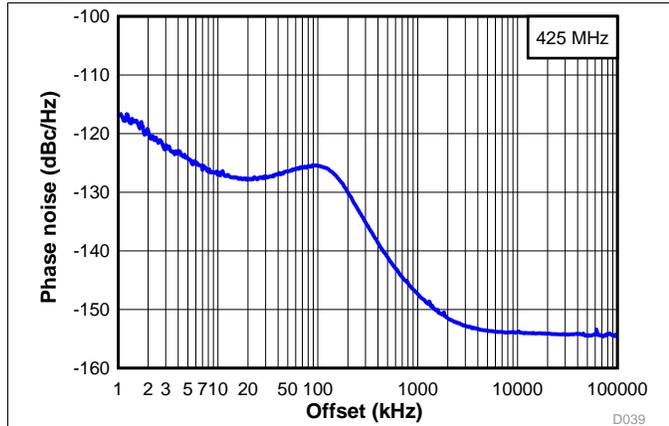


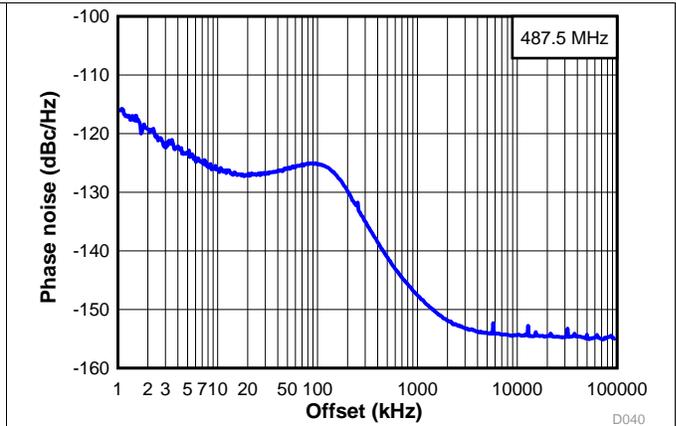
Figure 8. Open-Loop VCO Phase Noise at 737.5 MHz

**Typical Characteristics (continued)**

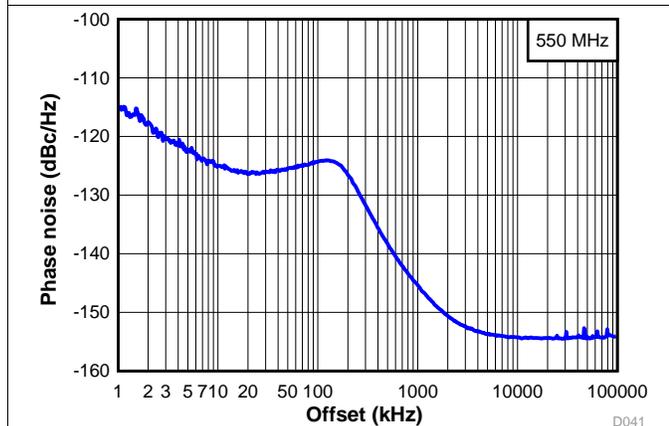
At  $T_A = 25^\circ\text{C}$ , unless otherwise noted



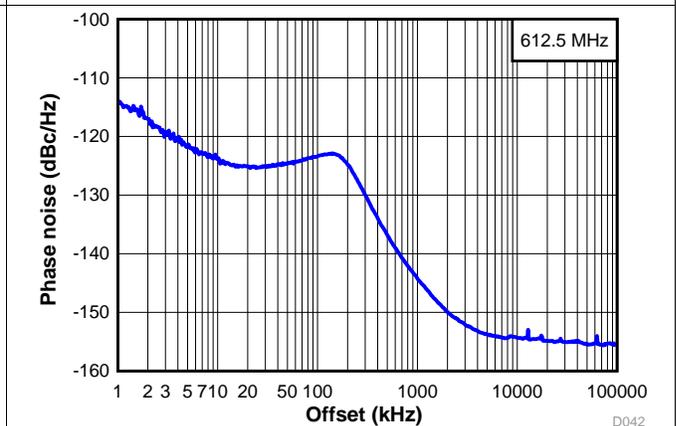
**Figure 9. Wide Band Phase Noise at 425 MHz**



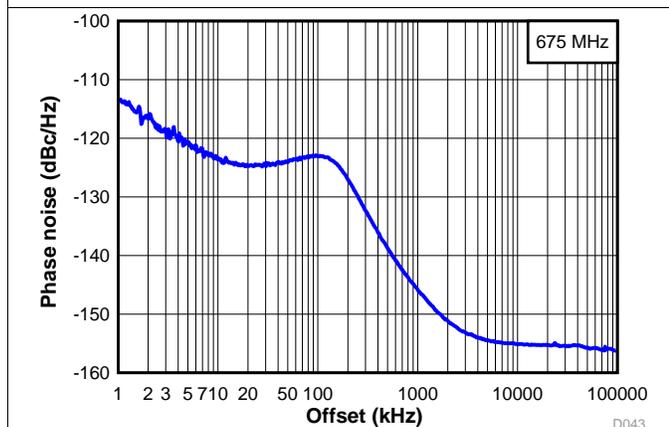
**Figure 10. Wide Band Phase Noise at 487.5 MHz**



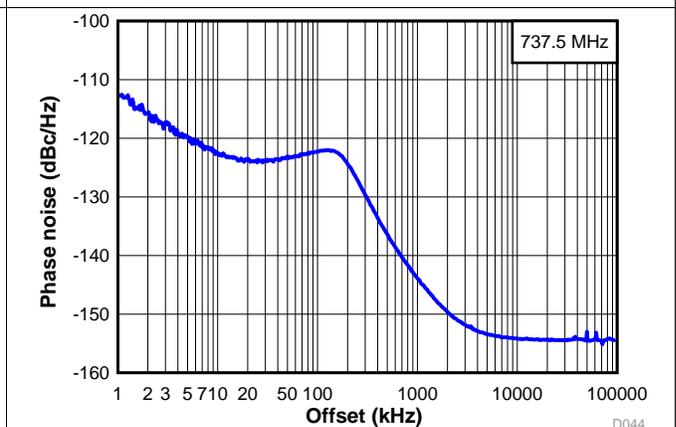
**Figure 11. Wide Band Phase Noise at 550 MHz**



**Figure 12. Wide Band Phase Noise at 612.5 MHz**



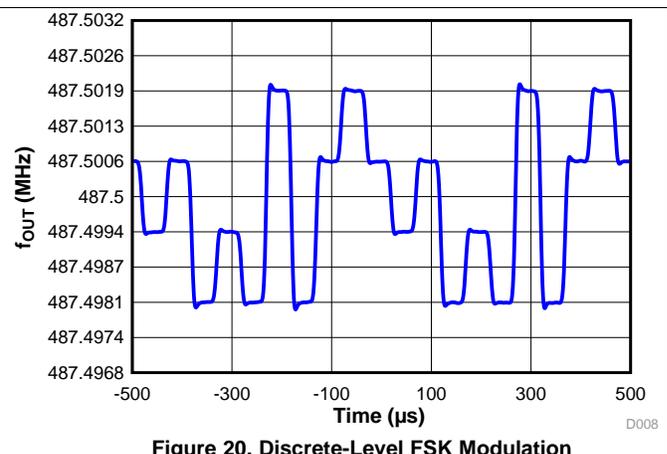
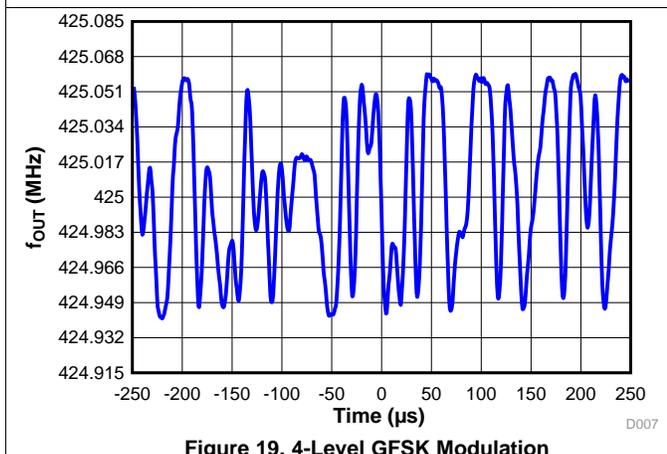
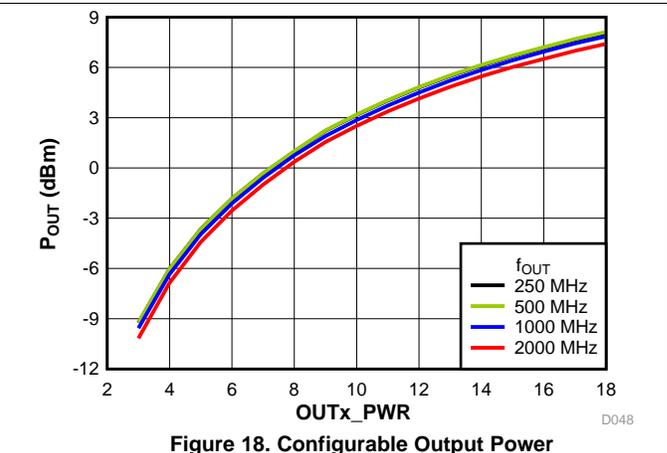
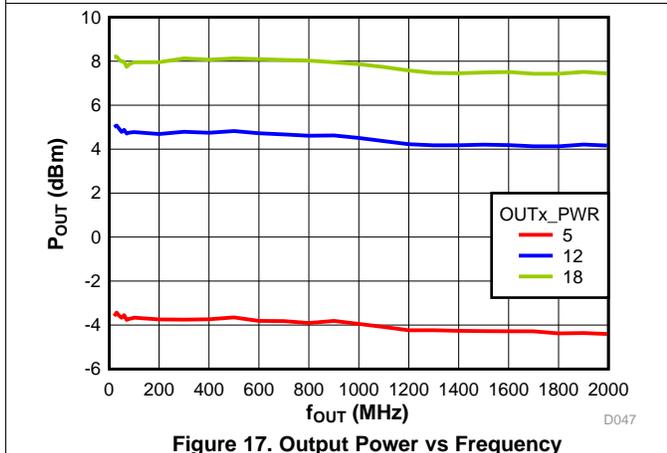
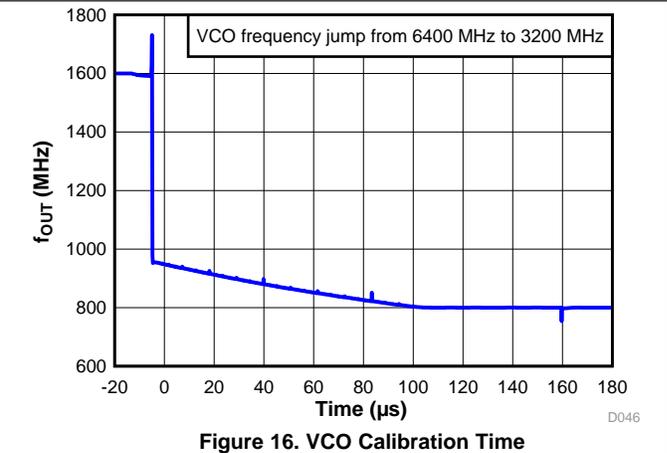
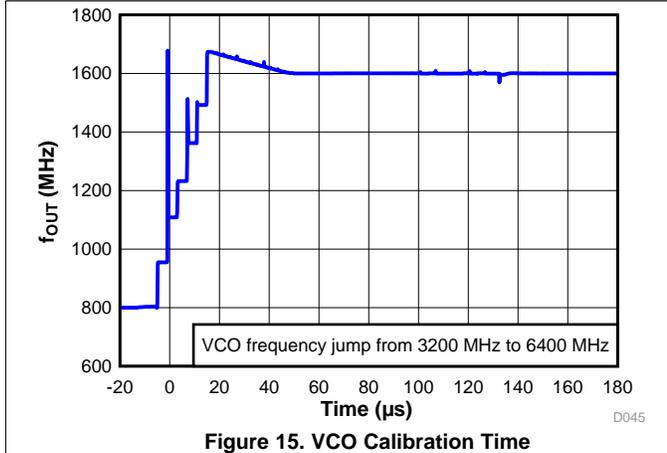
**Figure 13. Wide Band Phase Noise at 675 MHz**



**Figure 14. Wide Band Phase Noise at 737.5 MHz**

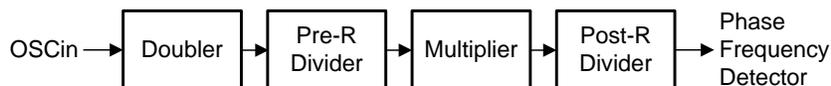
Typical Characteristics (continued)

At  $T_A = 25^\circ\text{C}$ , unless otherwise noted





## Feature Description (continued)



**Figure 21. Reference Path**

The Doubler allows one to double the input reference frequency up to 250 MHz. The Doubler adds minimal noise and is useful for raising the phase detector frequency for better phase noise. The Doubler can also be used to avoid spurs. The Doubler uses both the rising and falling edges of the input signal, so the input signal must have 50% duty cycle if the Doubler is enabled. Note that the Multiplier cannot be used if the Doubler is engaged.

The Pre-R divider can help reduce input frequency so that the Multiplier can be used and the maximum 200-MHz input frequency limitation of the Post-R divider can be met.

The Multiplier multiplies the frequency up under the allowable multiplications of 3, 4, 5, 6, and 7. In combination with the Pre-R and Post-R dividers, the Multiplier offers the flexibility to shift the phase detector frequency away from frequencies that may create integer boundary spurs with the VCO and the output frequencies. Be aware that unlike the Doubler, the Multiplier degrades the PLL figure of merit. This degradation would only matter, however, for a very clean reference oscillator input and if the loop bandwidth was wide. The user should not use the Doubler while using the Multiplier. The Multiplier is bypassed if its value is set to 1.

The Post-R divider can be used to further divide down the frequency to the phase detector frequency. When it is used (PLL\_R > 1), the input frequency to this divider is limited to 200 MHz.

Use [Equation 1](#) to calculate the phase detector frequency,  $f_{PD}$ .

$$f_{PD} = f_{OSCin} \times OSC\_2X \times MULT / (PLL\_R\_PRE \times PLL\_R) \quad (1)$$

[Table 1](#) summarizes the usage boundaries of these functional blocks in the reference path.

**Table 1. Reference Path Boundaries**

PARAMETER	VALUE	INPUT FREQUENCY (MHz)		OUTPUT FREQUENCY (MHz)		NOTES
		MIN	MAX	MIN	MAX	
OSCin	N/A	5	250			
Doubler	0 (Bypassed), 1 (x2)	5	125	10	250	When OSC_2X = 1, Multiplier cannot be used at the same time.
Pre-R divider	1 (Bypassed), 2, 3, ..., 254, 255	5	200	0.25	200	Keep it equals 1 unless when necessary.
Multiplier	1 (Bypassed), 3, 4, 5, 6, 7	10	40	60	150	When the output frequency is greater than 100MHz, set MULT_HI = 1.
Post-R divider	1 (Bypass), 2, 3, ..., 254, 255	5	200	0.25	200	

### 7.3.3 PLL Phase Detector and Charge Pump

The phase detector compares the outputs of the Post-R divider and N divider and generates a correction current corresponding to the phase error until the two signals are aligned in phase. This charge-pump current is software programmable to many different levels, allowing modification of the closed-loop bandwidth of the PLL.

**Table 2. Charge Pump Gain**

CGP	0	1	2	3	4 or 8	5 or 9	6 or 10	7 or 11	12	13	14	15	UNIT
Gain	Tri-state	625	1250	1875	2500	3125	3750	4375	5000	5625	6250	6875	μA

### 7.3.4 PLL N Divider and Fractional Circuitry

The N divider includes fractional compensation and can achieve any fractional denominator (PLL\_DEN) from 1 to  $(2^{32} - 1)$ . The integer portion of N (PLL\_N) is the whole part of the N divider value, and the fractional portion,  $N_{frac} = PLL\_NUM / PLL\_DEN$ , is the remaining fraction. PLL\_N, PLL\_NUM and PLL\_DEN are software programmable. The higher the denominator, the finer the resolution step of the output. For example, even when using  $f_{PD} = 200$  MHz, the output can increment in steps of  $200 \text{ MHz} / (2^{32} - 1) = 0.0466 \text{ Hz}$ . Equation 2 shows the relationship between the phase detector and VCO frequencies. Note that in SYNC mode, there is an extra divider that is not shown in Equation 2.

$$f_{VCO} = f_{PD} \times [PLL\_N + (PLL\_NUM / PLL\_DEN)] \tag{2}$$

The multi-stage noise-shaping (MASH) sigma-delta modulator that controls the fractional division is also programmable from integer mode to fourth order. All of these settings work for integer channel where PLL\_NUM = 0. To make the fractional spurs consistent, the modulator is reset any time that the R0 register is programmed.

The N divider has minimum value restrictions based on the modulator order. Furthermore, the PFD\_DLY\_SEL bit must be programmed in accordance to Table 3.

**Table 3. Minimum N Divider Restrictions**

VCO FREQUENCY (GHz)	MASH ORDER									
	INTEGER		FIRST ORDER		SECOND ORDER		THIRD ORDER		FOURTH ORDER	
	N	PFD_DLY_SEL	N	PFD_DLY_SEL	N	PFD_DLY_SEL	N	PFD_DLY_SEL	N	PFD_DLY_SEL
$f_{VCO} < 4$	20	0	25	1	26	1	32	2	44	4
$4 \leq f_{VCO} < 4.9$	24	1	29	2	30	2	32	2	44	4
$4.9 \leq f_{VCO} \leq 6.4$	24	1	29	2	30	2	36	3	48	5

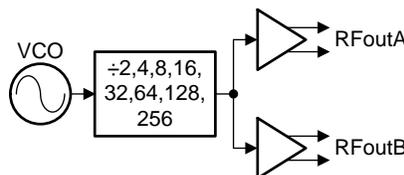
### 7.3.5 Voltage-Controlled Oscillator

The LMX2572LP includes a fully integrated VCO. The VCO generates a frequency which varies with the tuning voltage from the loop filter. The entire VCO frequency range, 3.2 to 6.4 GHz, covers an octave that allows the channel divider to take care of frequencies below the lower bound.

To reduce the VCO tuning gain, thus improving the VCO phase noise performance, the VCO frequency range is divided into 6 different frequency bands. This creates the need for frequency calibration to determine the correct frequency band given in a desired output frequency. The VCO is also calibrated for amplitude to optimize phase noise. These calibration routines are activated any time that the R0 register is programmed with the FCAL\_EN bit equals one. It is important that a valid OSCin signal must present before VCO calibration begins. This device will support a full sweep of the valid temperature range of 125°C (–40°C to 85°C) without having to re-calibrate the VCO. This is important for continuous operation of the synthesizer under the most extreme temperature variation.

### 7.3.6 Channel Divider

To go below the VCO lower bound of 3.2 GHz, the channel divider can be used. The channel divider consists of several segments, and the total division value is equal to the multiplication of them. Therefore, not all values are valid.



**Figure 22. Channel Divider**

### 7.3.7 Output Buffer

The output buffers are differential push-pull type buffers, thus no external pullup to  $V_{CC}$  is required. The output impedance of the buffer is very small, and as such, the buffer can be AC-coupled to drive a 50-Ω load. Output power of the buffer can be programmed to various levels. The buffer can be disabled while still keeping the PLL in lock.

### 7.3.8 Lock Detect

The MUXout pin can be configured to output a signal that gives an indication for the PLL being locked. If the MUXout pin is configured as a lock detect output (MUXOUT\_LD\_SEL = 1), the MUXout pin output is a logic HIGH voltage when the device is locked. When the device is unlocked, the MUXout pin output is a logic LOW voltage.

There are options to select the definition of PLL being locked. If LD\_TYPE = 0, lock detect asserts a HIGH output after the VCO has finished calibration and the LD\_DLY timeout counter is finished. If LD\_TYPE = 1, in addition to the VCO calibration and counter check, lock detect will assert a HIGH output if the VCO tuning voltage is also within an acceptable limits.

### 7.3.9 Register Readback

The MUXout pin can also be configured to read back useful information from the device. Common uses for readback are:

- Read back registers to ensure that they have been programmed to the correct value. LMX2572LP allows any of its registers to be read back.
- Read back the lock detect status to determine if the PLL is in lock.
- Read back VCO calibration information so that it can be used to improve the lock time.

### 7.3.10 Powerdown

The user can use the CE pin or the POWERDOWN bit to power the LMX2572LP up or down. All registers are preserved in memory while the device is powered down.

The wake-up time for the device to come out of the powered state is adjustable. See [Power-Up, Wake-Up Time](#) for details.

### 7.3.11 Phase Synchronization

The SYNC pin allows the user to synchronize the LMX2572LP such that the delay from the rising edge of the OSCin signal to the RF output signal is deterministic. Phase synchronization is especially useful if there are multiple LMX2572LP devices in a system and it is desirable to have all the RF outputs aligned in phase.

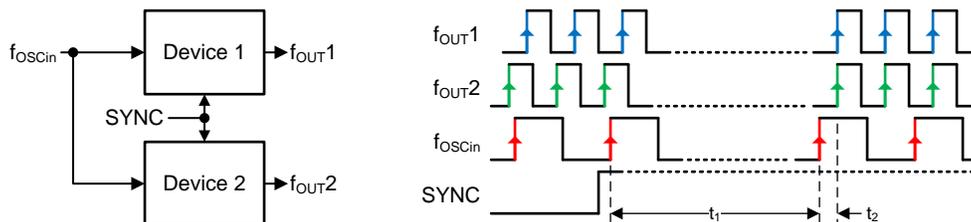


Figure 23. Phase Synchronization

Initially, the devices are locked to the input but are not synchronized. The user sends a synchronization pulse that is re-clocked to the next rising edge of the OSCin pulse. After a given time,  $t_1$ , the devices are synchronized. This time is dominated by the sum of the VCO calibration time, the analog settling time of the PLL loop, and the MASH\_RST\_COUNT, if used in fractional mode. After synchronization, both devices will have a deterministic delay of  $t_2$ , related to OSCin.

### 7.3.12 Phase Adjustment

The LMX2572LP can use the sigma-delta modulator to adjust the output signal phase with respect to the input reference. The phase shift every time you write the value of MASH\_SEED is [Equation 3](#):

$$\text{Phase shift in degree} = 360^\circ \times (\text{MASH\_SEED} / \text{PLL\_DEN}) \times (P / \text{CHDIV})$$

where

- $P = 2$  when VCO\_PHASE\_SYNC\_EN = 1, else  $P = 1$  (3)

For example, if

- MASH\_SEED = 800
- PLL\_DEN = 1000
- CHDIV = 32
- VCO\_PHASE\_SYNC\_EN = 0

Phase shift =  $360^\circ \times (800 / 1000) \times (1 / 32) = 9^\circ$ . If we write 800 to MASH\_SEED 40 times, then we will shift the phase by  $360^\circ$ .

There are a couple of restrictions when using phase adjustment:

- Phase adjustment does not work with MASH\_ORDER equals 0 (Integer mode) or 1 (First order).
- Phase adjustment is possible with integer channels (PLL\_NUM = 0) as long as MASH\_ORDER is greater than 1.
- PLL\_DEN must be greater than PLL\_NUM + MASH\_SEED.

### 7.3.13 Ramping Function

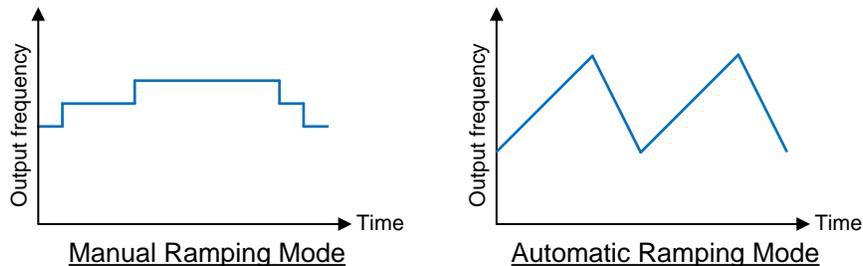
The LMX2572LP supports the ability to make frequency ramping waveforms using manual mode or automatic mode.

In manual ramping mode, the user defines a step and uses the RampClk and RampDir pins to create the ramp. The output frequency jumps from one frequency to another frequency on each ramp.

In automatic ramping mode, the user sets up the ramp with up to two linear segments in advance and the device automatically creates this ramp. The output waveform is a continuous frequency sweep between the start and end frequencies. If the frequency ramping range is small (approximately 10 MHz), no VCO calibration break is necessary in the middle of the ramp.

When using ramp, the following must be set accordingly:

- Phase detector frequency must be between  $f_{\text{OSCin}} / 2^{\text{CAL\_CLK\_DIV}}$  and 125 MHz.
- OUT\_FORCE = 1 to force the RF outputs not to be automatically muted during VCO calibration.
- LD\_DLY = 0 to avoid interfering with VCO calibration.
- PLL\_DEN =  $2^{32} - 1$ . The actual denominator value being used in ramping mode is  $2^{24}$ .



**Figure 24. Ramping Modes**

### 7.3.14 FSK Modulation

Direct digital FSK modulation is supported in LMX2572LP. FSK modulation is achieved by changing the output frequency by changing the N divider value. The LMX2572LP supports three different types of FSK operation.

1. FSK SPI mode. This mode supports discrete 2-, 4- and 8-level FSK modulation. There are eight dedicated registers used to pre-store the desired FSK frequency deviations. Program FSK\_SPI\_DEV\_SEL to select one of the FSK deviations at a time.
2. FSK SPI FAST mode. In this mode, instead of selecting one of the pre-stored FSK deviations, change the FSK deviation directly by writing to FSK\_SPI\_FAST\_DEV. As a result, this mode supports arbitrary-level FSK, which is useful to construct pulse-shaping or analog-FM modulation.
3. FSK I2S mode. This mode is similar to the FSK SPI FAST mode, but the programming format is an I2S format on dedicated pins instead of SPI. The benefit of using I2S is that this interface could be shared and synchronous to other digital audio interfaces. In this mode, only the 16 bits of the DATA field are required to program. The data is transmitted on the high or low side of the frame sync (programmable in register R114,

FSK\_I2S\_FS\_POL). The unused side of the frame sync needs to be at least one clock cycle. In other words, 17 (16 + 1) CLK cycles are required at a minimum for one I2S frame. Maximum I2S clock rate is 75 MHz. Timing diagram is shown in Figure 26 while the timing specification is same as SPI write timing as shown in the *Timing Requirements* section.

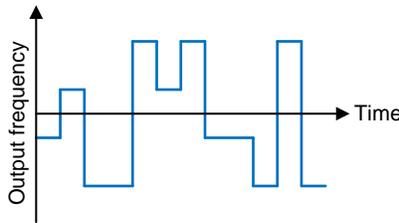


Figure 25. FSK Modulation

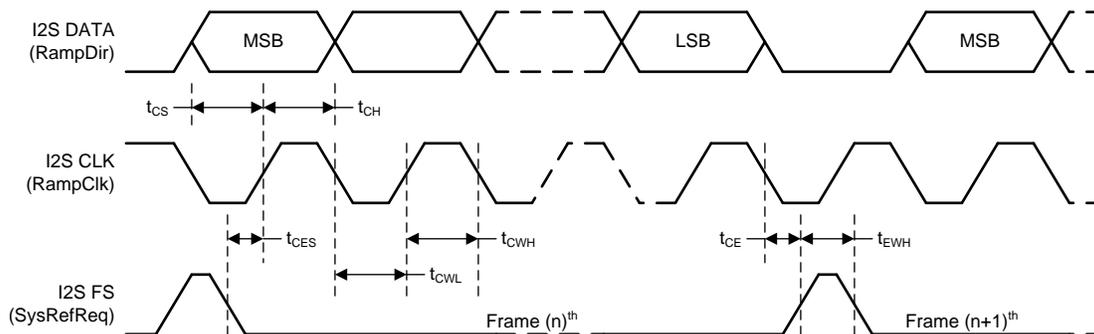


Figure 26. FSK I2S Timing Diagram

## 7.4 Device Functional Modes

Table 4 lists the device functional modes of the LMX2572LP.

Table 4. Device Functional Modes

MODE	DESCRIPTION
Normal operation mode	The device is used as a high frequency signal source without any addition features.
FSK mode	Generates discrete-level FSK or arbitrary-level pulse-shaped FSK modulation.
SYNC mode	This mode is used to ensure deterministic phase between OSCin and RFout.
Ramping mode	Automatic frequency sweeping without the need of continuous SPI programming.

## 7.5 Programming

The LMX2572LP is programmed using several 24-bit shift registers. The shift register consists of a data field, an address field, and a R/W bit. The MSB is the R/W bit. 0 means register write while 1 means register read. The following seven bits, ADDR[6:0], form the address field which is used to decode the internal register address. The remaining 16 bits form the data field DATA[15:0]. Serial data is shifted MSB first into the shift register. See Figure 1 for timing diagram details.

To write registers:

- The R/W bit must be set to 0.
- The data on SDI pin is clocked into the shift register upon the rising edge of the clocks on SCK pin. On the rising edge of the 24<sup>th</sup> clock cycle, the data is transferred from the data field into the selected register bank.
- The CSB pin may be held high after programming, which causes the LMX2572LP to ignore clock pulses.
- If the SCK and SDI lines are toggled while the VCO is in lock, as is sometimes the case when these lines are shared between devices, the phase noise may be degraded during the time of this programming.

## Programming (continued)

To read back registers:

- The R/W bit must be set to 1.
- The data field contents on the SDI line are ignored.
- The read back data on MUXout pin is clocked out starting from the falling edge of the 8<sup>th</sup> clock cycle.

### 7.5.1 Recommended Initial Power-On Programming

#### 7.5.1.1 Programming Sequence

When the device is first powered up, it must be initialized, and the ordering of this programming is important. The sequence is listed below. After this sequence is completed, the device should be running and locked to the proper frequency.

1. Apply power to the device and ensure all the supply pins are at the proper levels.
2. If CE is low, pull it high.
3. Wait 500  $\mu$ s for the internal LDOs to become stable.
4. Ensure that a valid reference clock is applied to the OSCin pins.
5. Program register R0 with RESET = 1. This will ensure all the registers are reset to their default values. This bit is self-clearing.
6. Program in sequence registers R125, R124, R123, ..., R1 and then R0.

#### 7.5.1.2 Programming Register

There are altogether 126 programmable registers. However, not every register is required to be programmed at initial power-on.

For example, most of the registers have fixed field value which is also equal to their silicon default value. After programming R0 with RESET = 1, these register fields have returned to their silicon default values. As such, it is not necessary to program these registers again. Similarly, for those registers having configurable fields, if the desired field values are equal to the silicon default values, again it is not necessary to program these registers again after programming R0 with RESET = 1.

In [Table 5](#), *Depends* means it is up to the user's decision of whether programming the register or not based upon the application need.

**Table 5. Suggested Register Programming**

REGISTER	PROGRAM										
0	Yes	21	No	42	Yes	63	No	84	Depends	105	Depends
1	Depends	22	No	43	Yes	64	No	85	Depends	106	Depends
2	No	23	No	44	Depends	65	No	86	Depends	107	No
3	No	24	No	45	Depends	66	No	87	No	108	No
4	No	25	No	46	No	67	No	88	No	109	No
5	Depends	26	No	47	No	68	No	89	No	110	No
6	Depends	27	No	48	No	69	Depends	90	No	111	No
7	Depends	28	No	49	No	70	Depends	91	No	112	No
8	Depends	29	Yes	50	No	71	Yes	92	No	113	No
9	Depends	30	Yes	51	No	72	No	93	No	114	Depends
10	Depends	31	No	52	Yes	73	No	94	No	115	Depends
11	Depends	32	No	53	No	74	No	95	No	116	Depends
12	Depends	33	No	54	No	75	Depends	96	Depends	117	Depends
13	No	34	Depends	55	No	76	No	97	Depends	118	Depends
14	Depends	35	No	56	No	77	No	98	Depends	119	Depends
15	No	36	Yes	57	Yes	78	Yes	99	Depends	120	Depends
16	Depends	37	Yes	58	Depends	79	Depends	100	Depends	121	Depends
17	Depends	38	Yes	59	Depends	80	Depends	101	Depends	122	Depends
18	No	39	Yes	60	Depends	81	Depends	102	Depends	123	Depends
19	Depends	40	Depends	61	No	82	Depends	103	Depends	124	Depends

## Programming (continued)

**Table 5. Suggested Register Programming (continued)**

REGISTER	PROGRAM										
20	Depends	41	Depends	62	Depends	83	Depends	104	Depends	125	No

### 7.5.2 Recommended Sequence for Changing Frequencies

The recommended sequence for changing frequencies in different scenarios is as follows:

1. If the N divider is changing, program the relevant registers and then program R0 with FCAL\_EN = 1.
2. In FSK and Ramp mode, the fractional numerator is changing; program the relevant registers only.

### 7.5.3 Double Buffering

Some register fields support double buffering. That is, the change to these fields would not be effective immediately. To latch the new values into the device requires programming R0 again with FCAL\_EN = 1. The following register fields support double buffering, see [Table 69](#) for details.

- MASH order (MASH\_ORDER)
- Fractional numerator (PLL\_NUM)
- N divider (PLL\_N)
- Doubler (OSC\_2X); Pre-R divider (PLL\_R\_PRE); Multiplier (MULT); Post-R divider (PLL\_R)

For example,

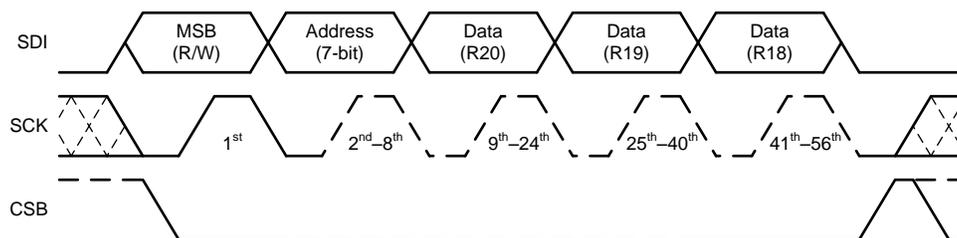
1. Program PLL\_R and PLL\_N to new values. If double buffering for these fields is enabled, the PLL will remain unchanged.
2. Program R0 with FCAL\_EN = 1. The PLL will calibrate and lock using the new PLL\_R and PLL\_N values.

### 7.5.4 Block Programming

In a register write sequence, instead of sending 24 bits (one W/R bit, seven address bits, and 16 data bits) of payload for each register (with Block Programming), only the first register write requires the W/R bit and the address bits. The succeeding registers require sending only the 16-bit of data. However, the succeeding registers must be in descending order. For example, if the first register is R20, then all 24 bits of payload must be sent for R20. The next register must be R19, but only the 16-bit data is required. The programming sequence is as follows:

1. Pull CSB pin LOW.
2. Write 0x14aaaa for R20.
3. Write 0xbbbb for R19, followed by 0xcccc for R18, and so on.
4. After the last register write is completed, pull CSB pin HIGH to finish Block Programming.

Since there is no CSB pulse between each register, the 16-bit of data field of each register can be sent immediately after the previous one.



**Figure 27. Block Programming Timing Example**

Block Programming applies to both register write and read.

## 7.6 Register Maps

REG.	DATA[15:0]															POR			
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1		0		
R0	RAMP_EN	VCO_PHASE_SYNC_EN	1	0	ADD_HOLD	0	OUT_MUTE	FCAL_HPFD_ADJ		FCAL_LPFD_ADJ		1	FCAL_EN	MUXOUT_LD_SEL	RESET	POWER DOWN	00221Ch		
R1	0	0	0	0	1	0	0	0	0	0	0	0	1	CAL_CLK_DIV			010808h		
R2	0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	020500h		
R3	0	0	0	0	0	1	1	1	1	0	0	0	0	0	1	0	030782h		
R4	0	0	0	0	1	0	1	0	0	1	0	0	0	0	1	1	040A43h		
R5	0	0	1	IPBUF_TYPE	IPBUF_TERM	0	0	0	1	1	0	0	1	0	0	0	0530C8h		
R6	LDO_DLY					0	0	0	0	0	0	0	0	0	1	0	06C802h		
R7	0	OUT_FORCE	0	0	0	0	0	0	1	0	1	1	0	0	1	0	0700B2h		
R8	0	VCO_DACISSET_FORCE	1	0	VCO_CAPCTRL_FORCE	0	0	0	0	0	0	0	0	0	0	0	082000h		
R9	0	MULT_HI	0	OSC_2X	0	0	0	0	0	0	0	0	0	1	0	0	090004h		
R10	0	0	0	1	MULT					1	1	1	1	0	0	0	0A10F8h		
R11	1	0	1	1	PLL_R							1	0	0	0	0	0	0BB018h	
R12	0	1	0	1	PLL_R_PRE										0	0	0	0	0C5001h
R13	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0D4000h		
R14	0	0	0	1	1	0	0	0	0	CPG			0	0	0	0	0E1840h		
R15	0	0	0	0	0	1	1	0	0	0	0	0	1	1	1	0	0F060Eh		
R16	0	0	0	0	0	0	0	VCO_DACISSET									100080h		
R17	0	0	0	0	0	0	0	VCO_DACISSET_STRT									110096h		
R18	0	0	0	0	0	0	0	0	0	1	1	0	0	1	0	0	120064h		
R19	0	0	1	0	0	1	1	1	VCO_CAPCTRL							1327B7h			
R20	0	1	VCO_SEL			VCO_SEL_FORCE	0	0	0	1	0	0	1	0	0	0	0	143048h	
R21	0	0	0	0	0	1	0	0	0	0	0	0	1	0	0	1	150409h		
R22	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	160001h		
R23	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0	0	17007Ch		
R24	0	0	0	0	0	1	1	1	0	0	0	1	1	0	1	0	18071Ah		
R25	0	0	0	0	0	1	1	0	0	0	1	0	0	1	0	0	190624h		
R26	0	0	0	0	1	0	0	0	0	0	0	0	1	0	0	0	1A0808h		
R27	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1B0002h		
R28	0	0	0	0	0	1	0	0	1	0	0	0	1	0	0	0	1C0488h		
R29	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1D18C6h		
R30	0	0	0	0	1	1	0	0	1	0	1	0	0	1	1	0	1E18C6h		
R31	1	1	0	0	0	0	1	1	1	1	1	0	0	1	1	0	1FC3E6h		
R32	0	0	0	0	0	1	0	1	1	0	1	1	1	1	1	1	2005BFh		
R33	0	0	0	1	1	1	1	0	0	0	0	0	0	0	0	1	211E01h		
R34	0	0	0	0	0	0	0	0	0	0	0	1	0	PLL_N[18:16]			220010h		

**Register Maps (continued)**

REG.	DATA[15:0]																POR	
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
R35	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	230004h	
R36	PLL_N																240028h	
R37	MASH_SEED_EN	0	PFD_DLY_SEL						0	0	0	0	0	0	1	0	1	250205h
R38	PLL_DEN[31:16]																26FFFFh	
R39	PLL_DEN[15:0]																27FFFFh	
R40	MASH_SEED[31:16]																280000h	
R41	MASH_SEED[15:0]																290000h	
R42	PLL_NUM[31:16]																2A0000h	
R43	PLL_NUM[15:0]																2B0000h	
R44	0	0	OUTA_PWR						OUTB_PD	OUTA_PD	MASH_RESET_N	0	0	MASH_ORDER				2C08A2h
R45	1	1	0	0	0	1	1	0	0	0	OUTB_PWR						2DC608h	
R46	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	2E07F0h	
R47	0	0	0	0	0	0	1	1	0	0	0	0	0	0	0	0	2F0300h	
R48	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	3003E0h	
R49	0	1	0	0	0	0	0	1	1	0	0	0	0	0	0	0	314180h	
R50	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	320080h	
R51	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	330080h	
R52	0	0	0	0	0	1	0	0	0	0	1	0	0	0	0	1	340420h	
R53	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	350000h	
R54	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	360000h	
R55	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	370000h	
R56	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	380000h	
R57	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	390000h	
R58	INPIN_IGNORE	INPIN_HYST	INPIN_LVL		INPIN_FMT			0	0	0	0	0	0	0	0	0	1	3A8001h
R59	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	LD_TYPE	3B0001h	
R60	LD_DLY																3C03E8h	
R61	0	0	0	0	0	0	0	0	1	0	1	0	1	0	0	0	3D00A8h	
R62	DBLBUF_EN_5	DBLBUF_EN_4	DBLBUF_EN_3	DBLBUF_EN_2	DBLBUF_EN_1	DBLBUF_EN_0	0	0	1	0	1	0	1	1	1	1	3E00AFh	
R63	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	3F0000h	
R64	0	0	0	1	0	0	1	1	1	0	0	0	1	0	0	0	401388h	
R65	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	410000h	
R66	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	4201F4h	
R67	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	430000h	
R68	0	0	0	0	0	0	1	1	1	1	1	0	1	0	0	0	4403E8h	
R69	MASH_RST_COUNT[31:16]																450000h	
R70	MASH_RST_COUNT[15:0]																46C350h	

**Register Maps (continued)**

REG.	DATA[15:0]																POR	
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
R71	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	1	470080h	
R72	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	480001h	
R73	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	49003Fh	
R74	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	4A0000h	
R75	0	0	0	0	1	CHDIV					0	0	0	0	0	0	0	4B0800h
R76	0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	0	4C000Ch	
R77	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	4D0000h	
R78	0	0	0	0	RAMP_THRESH[32]	0	QUICK_RECAL_EN	VCO_CAPCTRL_STRT								1	4E0064h	
R79	RAMP_THRESH[31:16]																4F0000h	
R80	RAMP_THRESH[15:0]																500000h	
R81	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	RAMP_LIMIT_HIGH[32]	510000h	
R82	RAMP_LIMIT_HIGH[31:16]																520000h	
R83	RAMP_LIMIT_HIGH[15:0]																530000h	
R84	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	RAMP_LIMIT_LOW[32]	540000h	
R85	RAMP_LIMIT_LOW[31:16]																550000h	
R86	RAMP_LIMIT_LOW[15:0]																560000h	
R87	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	570000h	
R88	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	580000h	
R89	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	590000h	
R90	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5A0000h	
R91	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5B0000h	
R92	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5C0000h	
R93	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5D0000h	
R94	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5E0000h	
R95	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5F0000h	
R96	RAMP_BURST_EN	RAMP_BURST_COUNT														0	0	600000h
R97	RAMP0_RST	0	0	0	0	RAMP_TRIGB				RAMP_TRIGA				0	RAMP_BURST_TRIG		610000h	
R98	RAMP0_INC[29:16]															0	RAMP0_DLY	620000h
R99	RAMP0_INC[15:0]																630000h	
R100	RAMP0_LEN																640000h	
R101	0	0	0	0	0	0	0	0	0	RAMP1_DLY	RAMP1_RST	RAMP0_NEXT	0	0	RAMP0_NEXT_TRIG		650000h	
R102	0	0	RAMP1_INC[29:16]														660000h	
R103	RAMP1_INC[15:0]																670000h	
R104	RAMP1_LEN																680000h	
R105	RAMP_DLY_CNT										RAMP_MANUAL	RAMP1_NEXT	0	0	RAMP1_NEXT_TRIG		694440h	

**Register Maps (continued)**

REG.	DATA[15:0]																POR
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
R106	0	0	0	0	0	0	0	0	0	0	0	RAMP_TRIG_CAL	0	RAMP_SCALE_COUNT			6A0007h
R107	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	6B0000h
R108	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	6C0000h
R109	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	6D0000h
R110	0	0	0	0	0	rb_LD_VTUNE		0	rb_VCO_SEL			0	0	0	0	0	6E0000h
R111	0	0	0	0	0	0	0	rb_VCO_CAPCTRL								6F0000h	
R112	0	0	0	0	0	0	0	rb_VCO_DACISSET								700000h	
R113	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	710000h
R114	0	1	1	1	1	FSK_EN	0	FSK_I2S_FS_POL	FSK_I2S_CLK_POL	FSK_SPI_LEVEL		FSK_SPI_DEV_SEL			FSK_MODE_SEL		727800h
R115	0	0	0	0	0	0	0	0	FSK_DEV_SCALE				0	0	0	730000h	
R116	FSK_DEV0																740000h
R117	FSK_DEV1																750000h
R118	FSK_DEV2																760000h
R119	FSK_DEV3																770000h
R120	FSK_DEV4																780000h
R121	FSK_DEV5																790000h
R122	FSK_DEV6																7A0000h
R123	FSK_DEV7																7B0000h
R124	FSK_SPI_FAST_DEV																7C0000h
R125	0	0	0	0	1	0	0	0	0	0	0	1	0	0	0	0	7D0820h

Table 6 lists the access codes for the LMX2572 registers.

**Table 6. Access Type Codes**

ACCESS TYPE	CODE	DESCRIPTION
<b>Read Type</b>		
R	R	Read
<b>Write Type</b>		
W	W	Write
<b>Reset or Default Value</b>		
-n		Value after reset

### 7.6.1 Register R0 (offset = 00h) [reset = 221Ch]

**Figure 28. Register R0**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_EN	VCO_PHASE_SYNC_EN	1	0	ADD_HOLD	0	OUT_MUTE	FCAL_HPFD_ADJ		FCAL_LPFD_ADJ		1	FCAL_EN	MUXOUT_LOADSEL	RESET	POWER_DOWN
R/W-0h	R/W-0h	R/W-2h		R/W-0h	R/W-0h	R/W-1h	R/W-0h		R/W-0h		R/W-1h	R/W-1h	R/W-1h	R/W-0h	R/W-0h

**Table 7. Register R0 Field Descriptions**

Bit	Field	Type	Reset	Description
15	RAMP_EN	R/W	0h	Enables frequency ramping. The action of programming register R0 with RAMP_EN = 1 starts the ramping. Be aware that this is in the same register as FCAL_EN, so toggling this bit also can active the ramping if RAMP_EN = 1. RAMP_EN applies to both automatic and manual ramping modes. 0: Normal operation 1: Starts frequency ramping
14	VCO_PHASE_SYNC_EN	R/W	0h	Enables phase sync mode. In this state, part of the channel divider is put in the feedback path to ensure deterministic phase. The action of toggling this bit from 0 to 1 also sends an asynchronous SYNC pulse. 0: Normal operation 1: Phase sync mode
13 - 12		R/W	2h	Program 2h to this field.
11	ADD_HOLD	R/W	0h	Freeze the register address in Block Programming. See <a href="#">Block Programming</a> for details.
10		R/W	0h	Program 0h to this field.
9	OUT_MUTE	R/W	1h	Mutes RF outputs (RFoutA and RFoutB) when the VCO is calibrating. 0: Disabled 1: Muted
8 - 7	FCAL_HPFD_ADJ	R/W	0h	Set this field in accordance to the phase detector frequency for optimal VCO calibration. 0: $f_{PD} \leq 37.5$ MHz 1: $37.5$ MHz < $f_{PD} \leq 75$ MHz 2: $75$ MHz < $f_{PD} \leq 100$ MHz 3: $f_{PD} > 100$ MHz
6 - 5	FCAL_LPFD_ADJ	R/W	0h	Set this field in accordance to the phase detector frequency for optimal VCO calibration. 0: $f_{PD} \geq 10$ MHz 1: $10$ MHz > $f_{PD} \geq 5$ MHz 2: $5$ MHz > $f_{PD} \geq 2.5$ MHz 3: $f_{PD} < 2.5$ MHz
4		R/W	1h	Program 1h to this field.
3	FCAL_EN	R/W	1h	Enables and activates VCO frequency calibration. Writing register R0 with this bit set to a 1 enables and triggers the VCO frequency calibration. Writing 0 to this field is prohibited. 0: Invalid 1: Enabled

**Table 7. Register R0 Field Descriptions (continued)**

Bit	Field	Type	Reset	Description
2	MUXOUT_LD_SEL	R/W	1h	Selects the functionality of the MUXout pin. 0: Register readback 1: Lock detect
1	RESET	R/W	0h	Resets all registers to silicon default values. This bit is self-clearing. 0: Normal operation 1: Reset
0	POWERDOWN	R/W	0h	Powers down the device. 0: Normal operation 1: Power down

**7.6.2 Register R1 (offset = 01h) [reset = 0808h]**
**Figure 29. Register R1**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	0	0	0	0	0	0	0	1	CAL_CLK_DIV		
R/W-101h													R/W-0h		

**Table 8. Register R1 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 3		R/W	101h	Program 101h to this field.
2 - 0	CAL_CLK_DIV	R/W	0h	Divides down the state machine clock during VCO calibration. Maximum state machine clock frequency is 200 MHz. State machine clock frequency = $f_{OSCin} / (2^{CAL\_CLK\_DIV})$ . 0: $f_{OSCin} \leq 200$ MHz 1: $200 \text{ MHz} < f_{OSCin} \leq 250$ MHz All other values are not used.

**7.6.3 Register R2 (offset = 02h) [reset = 0500h]**
**Figure 30. Register R2**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0
R/W-500h															

**Table 9. Register R2 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	500h	Program 500h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.4 Register R3 (offset = 03h) [reset = 0782h]**
**Figure 31. Register R3**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	1	1	0	0	0	0	0	1	0
R/W-782h															

**Table 10. Register R3 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	782h	Program 782h to this field. After programming R0 with RESET = 1, no need to program this register.

### 7.6.5 Register R4 (offset = 04h) [reset = 0A43h]

Figure 32. Register R4

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	0	1	0	0	1	0	0	0	0	1	1
R/W-A43h															

Table 11. Register R4 Field Descriptions

Bit	Field	Type	Reset	Description
15 - 0		R/W	A43h	Program A43h to this field. After programming R0 with RESET = 1, no need to program this register.

### 7.6.6 Register R5 (offset = 05h) [reset = 30C8h]

Figure 33. Register R5

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	1	IPBUF_T YPE	IPBUF_T ERM	0	0	0	1	1	0	0	1	0	0	0
R/W-1h			R/W-1h		R/W-0h			R/W-C8h							

Table 12. Register R5 Field Descriptions

Bit	Field	Type	Reset	Description
15 - 13		R/W	1h	Program 1h to this field.
12	IPBUF_TYPE	R/W	1h	Selects OSCin input type. 0: Differential input 1: Single-ended input
11	IPBUF_TERM	R/W	0h	Enables internal 50-Ω terminations on both OSCin and OSCin* pins. This function is valid even if OSCin input is configured as single-ended input. 0: Normal operation 1: OSCin and OSCin* pins are internally 50-Ω terminated
10 - 0		R/W	C8h	Program C8h to this field.

### 7.6.7 Register R6 (offset = 06h) [reset = C802h]

Figure 34. Register R6

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
LDO_DLY					0	0	0	0	0	0	0	0	0	1	0
R/W-19h										R/W-2h					

Table 13. Register R6 Field Descriptions

Bit	Field	Type	Reset	Description
15 - 11	LDO_DLY	R/W	19h	LDO start up delay. Delay duration is a function of state machine clock. See <a href="#">Power-Up, Wake-Up Time</a> for details.
10 - 0		R/W	2h	Program 2h to this field.

### 7.6.8 Register R7 (offset = 07h) [reset = 00B2h]

Figure 35. Register R7

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	OUT_FO RCE	0	0	0	0	0	0	1	0	1	1	0	0	1	0
R/W-0h		R/W-0h		R/W-B2h											

**Table 14. Register R7 Field Descriptions**

Bit	Field	Type	Reset	Description
15		R/W	0h	Program 0h to this field.
14	OUT_FORCE	R/W	0h	Forces the RF outputs not to be automatically muted during VCO calibration. This bit should be enabled during frequency ramping. 0: Mute setting depends on OUT_MUTE 1: No mute during VCO calibration
13 - 0		R/W	B2h	Program B2h to this field.

**7.6.9 Register R8 (offset = 08h) [reset = 2000h]**
**Figure 36. Register R8**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	VCO_DACIS ESET_F ORCE	1	0	VCO_CAP CTRL_ FORCE	0	0	0	0	0	0	0	0	0	0	0
R/W-0h	R/W-0h	R/W-2h		R/W-0h											R/W-0h

**Table 15. Register R8 Field Descriptions**

Bit	Field	Type	Reset	Description
15		R/W	0h	Program 0h to this field.
14	VCO_DACIS ESET_F ORCE	R/W	0h	Forces VCO_DACISSET value. Useful for fully-assisted VCO calibration and debugging purposes. 0: Normal operation 1: Use VCO_DACISSET value instead of the value obtained from VCO calibration
13 - 12		R/W	2h	Program 2h to this field.
11	VCO_CAP CTRL_ FORCE	R/W	0h	Forces VCO_CAPCTRL value. Useful for fully-assisted VCO calibration and debugging purposes. 0: Normal operation 1: Use VCO_CAPCTRL value instead of the value obtained from VCO calibration
10 - 0		R/W	0h	Program 0h to this field.

**7.6.10 Register R9 (offset = 09h) [reset = 0004h]**
**Figure 37. Register R9**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	MULT_H I	0	OSC_2X	0	0	0	0	0	0	0	0	0	1	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h												R/W-4h

**Table 16. Register R9 Field Descriptions**

Bit	Field	Type	Reset	Description
15		R/W	0h	Program 0h to this field.
14	MULT_HI	R/W	0h	Sets this bit to 1 if the output frequency of the Multiplier is greater than 100 MHz. 0: Multiplier output ≤ 100 MHz 1: Multiplier output > 100 MHz
13		R/W	0h	Program 0h to this field.
12	OSC_2X	R/W	0h	Enables reference path Doubler. 0: Disabled 1: Enabled
11 - 0		R/W	4h	Program 4h to this field.

**7.6.11 Register R10 (offset = 0Ah) [reset = 10F8h]**
**Figure 38. Register R10**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
0	0	0	1	MULT						1	1	1	1	0	0	0
R/W-1h				R/W-1h						R/W-7h						

**Table 17. Register R10 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 12		R/W	1h	Program 1h to this field.
11 - 7	MULT	R/W	1h	Reference path frequency Multiplier. Input frequency to the Multiplier: 10 to 40 MHz. Multiplier output frequency: 60 to 150 MHz. 0: Not used 1: Bypassed 2: Not recommended. Use OSC_2X instead of MULT 3: 3X ..... 7: 7X 8 - 31: Not recommended
6 - 0		R/W	78h	Program 78h to this field.

**7.6.12 Register R11 (offset = 0Bh) [reset = B018h]**
**Figure 39. Register R11**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	1	1	PLL_R						1	0	0	0		
R/W-Bh				R/W-1h						R/W-8h					

**Table 18. Register R11 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 12		R/W	Bh	Program Bh to this field.
11 - 4	PLL_R	R/W	1h	Reference path Post-R divider. It is the divider after the frequency Multiplier.
3 - 0		R/W	8h	Program 8h to this field.

**7.6.13 Register R12 (offset = 0Ch) [reset = 5001h]**
**Figure 40. Register R12**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	1	PLL_R_PRE											
R/W-5h				R/W-1h											

**Table 19. Register R12 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 12		R/W	5h	Program 5h to this field.
11 - 0	PLL_R_PRE	R/W	1h	Reference path Pre-R divider. It is the divider before the frequency Multiplier.

**7.6.14 Register R13 (offset = 0Dh) [reset = 4000h]**
**Figure 41. Register R13**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-4000h															

**Table 20. Register R13 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	4000h	Program 4000h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.15 Register R14 (offset = 0Eh) [reset = 1840h]**
**Figure 42. Register R14**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
0	0	0	1	1	0	0	0	0					CPG	0	0	0
R/W-30h										R/W-8h			R/W-0h			

**Table 21. Register R14 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 7		R/W	30h	Program 30h to this field.
6 - 3	CPG	R/W	8h	Effective charge pump gain. This is the sum of the up and down currents. Each increment represents 625 $\mu$ A. 0: Tri-state 1: 625 $\mu$ A 2: 1250 $\mu$ A 3: 1875 $\mu$ A ..... 15: 6875 $\mu$ A
2 - 0		R/W	0h	Program 0h to this field.

**7.6.16 Register R15 (offset = 0Fh) [reset = 060Eh]**
**Figure 43. Register R15**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	0	0	0	0	0	1	1	1	0
R/W-60Eh															

**Table 22. Register R15 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	60Eh	Program 60Eh to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.17 Register R16 (offset = 10h) [reset = 0080h]**
**Figure 44. Register R16**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0									
R/W-0h										VCO_DACISSET R/W-80h					

**Table 23. Register R16 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 9		R/W	0h	Program 0h to this field.
8 - 0	VCO_DACISSET	R/W	80h	Programmable current setting for the VCO that is applied when VCO_DACISSET_FORCE = 1. Useful for fully-assisted VCO calibration.

**7.6.18 Register R17 (offset = 11h) [reset = 0096h]**

**Figure 45. Register R17**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	VCO_DACISSET_STRT								
R/W-0h							R/W-96h								

**Table 24. Register R17 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 9		R/W	0h	Program 0h to this field.
8 - 0	VCO_DACISSET_STRT	R/W	96h	Starting calibration value for VCO_DACISSET.

**7.6.19 Register R18 (offset = 12h) [reset = 0064h]**

**Figure 46. Register R18**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	1	1	0	0	1	0	0
R/W-64h															

**Table 25. Register R18 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	64h	Program 64h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.20 Register R19 (offset = 13h) [reset = 27B7h]**

**Figure 47. Register R19**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	1	0	0	1	1	1	VCO_CAPCTRL							
R/W-27h							R/W-B7h								

**Table 26. Register R19 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 8		R/W	27h	Program 27h to this field.
7 - 0	VCO_CAPCTRL	R/W	B7h	Programmable band within VCO core that applies when VCO_CAPCTRL_FORCE = 1. Valid values are 183 to 0, where the higher number is a lower frequency.

**7.6.21 Register R20 (offset = 14h) [reset = 3048h]**

**Figure 48. Register R20**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
0	1	VCO_SEL			VCO_SEL_FORCE	0	0	0	1	0	0	1	0	0	0	
R/W-0h		R/W-6h			R/W-0h			R/W-48h								

**Table 27. Register R20 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 14		R/W	0h	Program 1h to this field.
13 - 11	VCO_SEL	R/W	6h	User specified start VCO for calibration. This sets the VCO that is used when VCO_SEL_STRT_EN = 1 or VCO_SEL_FORCE = 1. 1: VCO1 2: VCO2 ..... 6: VCO6 All other values are not used.

**Table 27. Register R20 Field Descriptions (continued)**

Bit	Field	Type	Reset	Description
10	VCO_SEL_FORCE	R/W	0h	Forces the VCO to use the core specified by VCO_SEL. 0: Disabled 1: Enabled
9 - 0		R/W	48h	Program 48h to this field.

**7.6.22 Register R21 (offset = 15h) [reset = 0409h]**
**Figure 49. Register R21**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	0	0	0	0	0	1	0	0	1
R/W-409h															

**Table 28. Register R21 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	409h	Program 409h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.23 Register R22 (offset = 16h) [reset = 0001h]**
**Figure 50. Register R22**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
R/W-1h															

**Table 29. Register R22 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	1h	Program 1h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.24 Register R23 (offset = 17h) [reset = 007Ch]**
**Figure 51. Register R23**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	1	1	1	1	1	0	0
R/W-7Ch															

**Table 30. Register R23 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	7Ch	Program 7Ch to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.25 Register R24 (offset = 18h) [reset = 071Ah]**
**Figure 52. Register R24**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	1	0	0	0	1	1	0	1	0
R/W-71Ah															

**Table 31. Register R24 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	71Ah	Program 71Ah to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.26 Register R25 (offset = 19h) [reset = 0624h]**
**Figure 53. Register R25**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	0	0	0	1	0	0	1	0	0
R/W-624h															

**Table 32. Register R25 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	624h	Program 624h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.27 Register R26 (offset = 1Ah) [reset = 0808h]**
**Figure 54. Register R26**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	0	0	0	0	0	0	0	1	0	0	0
R/W-808h															

**Table 33. Register R26 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	808h	Program 808h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.28 Register R27 (offset = 1Bh) [reset = 0002h]**
**Figure 55. Register R27**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
R/W-2h															

**Table 34. Register R27 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	2h	Program 2h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.29 Register R28 (offset = 1Ch) [reset = 0488h]**
**Figure 56. Register R28**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	0	1	0	0	0	1	0	0	0
R/W-488h															

**Table 35. Register R28 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	488h	Program 488h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.30 Register R29 (offset = 1Dh) [reset = 18C6h]**
**Figure 57. Register R29**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-18C6h															

**Table 36. Register R29 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	18C6h	Program 0h to this field.

**7.6.31 Register R30 (offset = 1Eh) [reset = 18C6h]**
**Figure 58. Register R30**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	1	0	0	1	0	1	0	0	1	1	0
R/W-18C6h															

**Table 37. Register R30 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	18C6h	Program CA6h to this field.

**7.6.32 Register R31 (offset = 1Fh) [reset = C3E6h]**
**Figure 59. Register R31**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	0	0	0	1	1	1	1	1	0	0	1	1	0
R/W-C3E6h															

**Table 38. Register R31 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	C3E6h	Program C3E6h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.33 Register R32 (offset = 20h) [reset = 05BFh]**
**Figure 60. Register R32**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	1	1	0	1	1	1	1	1	1
R/W-5BFh															

**Table 39. Register R32 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	5BFh	Program 5BFh to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.34 Register R33 (offset = 21h) [reset = 1E01h]**
**Figure 61. Register R33**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	1	1	1	1	0	0	0	0	0	0	0	0	1
R/W-1E01h															

**Table 40. Register R33 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	1E01h	Program 1E01h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.35 Register R34 (offset = 22h) [reset = 0010h]**
**Figure 62. Register R34**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	1	0	PLL_N[18:16]		
R/W-2h												R/W-0h			

**Table 41. Register R34 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 3		R/W	2h	Program 2h to this field.
2 - 0	PLL_N[18:16]	R/W	0h	Upper 3 bits of N-divider.

**7.6.36 Register R35 (offset = 23h) [reset = 0004h]**
**Figure 63. Register R35**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
R/W-4h															

**Table 42. Register R35 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	4h	Program 4h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.37 Register R36 (offset = 24h) [reset = 0028h]**
**Figure 64. Register R36**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PLL_N															
R/W-28h															

**Table 43. Register R36 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	PLL_N	R/W	28h	Lower 16 bits of N-divider.

**7.6.38 Register R37 (offset = 25h) [reset = 0205h]**
**Figure 65. Register R37**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MASH_S EED_EN	0	PFD_DLY_SEL						0	0	0	0	0	1	0	1
R/W-0h	R/W-0h	R/W-2h						R/W-5h							

**Table 44. Register R37 Field Descriptions**

Bit	Field	Type	Reset	Description
15	MASH_SEED_EN	R/W	0h	Enables the MASH_SEED value to be used. This can be used for programmable phase stepping or fractional spur optimization. 0: Disabled 1: Enabled
14		R/W	0h	Program 0h to this field.
13 - 8	PFD_DLY_SEL	R/W	2h	PFD_DLY_SEL must be adjusted in accordance to the N-divider value. See <a href="#">Table 3</a> for details.
7 - 0		R/W	5h	Program 5h to this field.

**7.6.39 Register R38 (offset = 26h) [reset = FFFFh]**
**Figure 66. Register R38**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PLL_DEN[31:16]															
R/W-FFFFh															

**Table 45. Register R38 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	PLL_DEN[31:16]	R/W	FFFFh	Upper 16 bits of fractional denominator (DEN).

**7.6.40 Register R39 (offset = 27h) [reset = FFFFh]**
**Figure 67. Register R39**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PLL_DEN[15:0]															
R/W-FFFFh															

**Table 46. Register R39 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	PLL_DEN[15:0]	R/W	FFFFh	Lower 16 bits of fractional denominator (DEN).

**7.6.41 Register R40 (offset = 28h) [reset = 0000h]**
**Figure 68. Register R40**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MASH_SEED[31:16]															
R/W-0h															

**Table 47. Register R40 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	MASH_SEED[31:16]	R/W	0h	Upper 16 bits of MASH_SEED. MASH_SEED sets the initial state of the fractional engine. Useful for producing a phase shift and fractional spur optimization.

**7.6.42 Register R41 (offset = 29h) [reset = 0000h]**
**Figure 69. Register R41**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MASH_SEED[15:0]															
R/W-0h															

**Table 48. Register R41 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	MASH_SEED[15:0]	R/W	0h	Lower 16 bits of MASH_SEED. MASH_SEED sets the initial state of the fractional engine. Useful for producing a phase shift and fractional spur optimization.

**7.6.43 Register R42 (offset = 2Ah) [reset = 0000h]**
**Figure 70. Register R42**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PLL_NUM[31:16]															
R/W-0h															

**Table 49. Register R42 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	PLL_NUM[31:16]	R/W	0h	Upper 16 bits of fractional numerator (NUM).

**7.6.44 Register R43 (offset = 2Bh) [reset = 0000h]**
**Figure 71. Register R43**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PLL_NUM[15:0]															
R/W-0h															

**Table 50. Register R43 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	PLL_NUM[15:0]	R/W	0h	Lower 16 bits of fractional numerator (NUM).

**7.6.45 Register R44 (offset = 2Ch) [reset = 08A2h]**
**Figure 72. Register R44**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	OUTA_PWR					OUTB_PD	OUTA_PD	MASH_RESET_N	0	0	MASH_ORDER			
R/W-0h		R/W-08h					R/W-1h	R/W-0h	R/W-1h	R/W-0h		R/W-2h			

**Table 51. Register R44 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 14		R/W	0h	Program 0h to this field.
13 - 8	OUTA_PWR	R/W	08h	Adjusts RfOutA output power. Higher numbers give more output power. Values greater than 18 are prohibited.
7	OUTB_PD	R/W	1h	Powers down RF output B. 0: Normal operation 1: Power down
6	OUTA_PD	R/W	0h	Powers down RF output A. 0: Normal operation 1: Power down
5	MASH_RESET_N	R/W	1h	Resets MASH. 0: Reset 1: Normal operation
4 - 3		R/W	0h	Program 0h to this field.

**Table 51. Register R44 Field Descriptions (continued)**

Bit	Field	Type	Reset	Description
2 - 0	MASH_ORDER	R/W	2h	Sets the MASH order. 0: Integer mode 1: First order modulator 2: Second order modulator 3: Third order modulator 4: Fourth order modulator 5 - 7: Not used

**7.6.46 Register R45 (offset = 2Dh) [reset = C608h]**
**Figure 73. Register R45**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	0	0	1	1	0	0	0	OUTB_PWR					
R/W-318h										R/W-08h					

**Table 52. Register R45 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 6		R/W	318h	Program 318h to this field.
5 - 0	OUTB_PWR	R/W	08h	Adjusts RfOutB output power. Higher numbers give more output power. Values greater than 18 are prohibited.

**7.6.47 Register R46 (offset = 2Eh) [reset = 07F0h]**
**Figure 74. Register R46**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0
R/W-7F0h															

**Table 53. Register R46 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	7F0h	Program 7F0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.48 Register R47 (offset = 2Fh) [reset = 0300h]**
**Figure 75. Register R47**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	1	1	0	0	0	0	0	0	0	0
R/W-300h															

**Table 54. Register R47 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	300h	Program 300h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.49 Register R48 (offset = 30h) [reset = 03E0h]**
**Figure 76. Register R48**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0
R/W-3E0h															

**Table 55. Register R48 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	3E0h	Program 3E0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.50 Register R49 (offset = 31h) [reset = 4180h]**
**Figure 77. Register R49**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	0	0	1	1	0	0	0	0	0	0	0
R/W-4180h															

**Table 56. Register R49 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	4180h	Program 4180h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.51 Register R50 (offset = 32h) [reset = 0080h]**
**Figure 78. Register R50**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
R/W-80h															

**Table 57. Register R50 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	80h	Program 80h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.52 Register R51 (offset = 33h) [reset = 0080h]**
**Figure 79. Register R51**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
R/W-80h															

**Table 58. Register R51 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	80h	Program 80h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.53 Register R52 (offset = 34h) [reset = 0420h]**
**Figure 80. Register R52**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	0	0	0	1	0	0	0	0	1
R/W-420h															

**Table 59. Register R52 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	420h	Program 421h to this field.

**7.6.54 Register R53 (offset = 35h) [reset = 0000h]**
**Figure 81. Register R53**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 60. Register R53 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.55 Register R54 (offset = 36h) [reset = 0000h]**
**Figure 82. Register R54**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 61. Register R54 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.56 Register R55 (offset = 37h) [reset = 0000h]**
**Figure 83. Register R55**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 62. Register R55 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.57 Register R56 (offset = 38h) [reset = 0000h]**
**Figure 84. Register R56**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 63. Register R56 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.58 Register R57 (offset = 39h) [reset = 0000h]**
**Figure 85. Register R57**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
R/W-0h															

**Table 64. Register R57 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 20h to this field.

**7.6.59 Register R58 (offset = 3Ah) [reset = 8001h]**
**Figure 86. Register R58**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
INPIN_I GNORE	INPIN_H YST	INPIN_LVL		INPIN_FMT			0	0	0	0	0	0	0	0	1
R/W-1h	R/W-0h	R/W-0h		R/W-0h			R/W-1h								

**Table 65. Register R58 Field Descriptions**

Bit	Field	Type	Reset	Description
15	INPIN_IGNORE	R/W	1h	Ignore SYNC and SysRefReq pins when VCO_PHASE_SYNC = 0. This bit should be set to 1 unless VCO_PHASE_SYNC = 1.
14	INPIN_HYST	R/W	0h	Enables high hysteresis for LVDS input to SysRefReq and SYNC pin. 0: Disabled 1: Enabled
13 - 12	INPIN_LVL	R/W	0h	Sets bias level for LVDS input to SysRefReq and SYNC pin. 0: Vin / 4 1: Vin 2: Vin / 2 3: Invalid
11 - 9	INPIN_FMT	R/W	0h	Defines the input format of SysRefReq and SYNC pin. 0: SYNC = SysRefReq = CMOS 1: SYNC = LVDS; SysRefReq = CMOS 2: SYNC = CMOS; SysRefReq = LVDS 3: SYNC = SysRefReq = LVDS 4: SYNC = SysRefReq = CMOS 5: SYNC = LVDS (filtered); SysRefReq = CMOS 6: SYNC = CMOS; SysRefReq = LVDS (filtered) 7: SYNC = SysRefReq = LVDS (filtered)
8 - 0		R/W	1h	Program 1h to this field.

**7.6.60 Register R59 (offset = 3Bh) [reset = 0001h]**
**Figure 87. Register R59**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	LD_TYP E
R/W-0h														R/W-1h	

**Table 66. Register R59 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 1		R/W	0h	Program 0h to this field.
0	LD_TYPE	R/W	1h	Defines lock detect type. 0: VCOCal. Lock detect asserts a HIGH output after the VCO has finished calibration and the LD_DLY timeout counter is finished. 1: Vtune and VCOCal. Lock detect asserts a HIGH output when VCOCal lock detect would assert a HIGH signal and the tuning voltage to the VCO is within acceptable limits.

**7.6.61 Register R60 (offset = 3Ch) [reset = 03E8h]**
**Figure 88. Register R60**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
LD_DLY															
R/W-3E8h															

**Table 67. Register R60 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	LD_DLY	R/W	3E8h	For the VCOCal lock detect, this is the delay in $\frac{1}{4} f_{PD}$ cycles that is added after the calibration is finished before the VCOCal lock detect is asserted HIGH.

**7.6.62 Register R61 (offset = 3Dh) [reset = 00A8h]**
**Figure 89. Register R61**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	1	0	1	0	1	0	0	0
R/W-A8h															

**Table 68. Register R61 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	A8h	Program A8h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.63 Register R62 (offset = 3Eh) [reset = 00AFh]**
**Figure 90. Register R62**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DBLBUF_EN_5	DBLBUF_EN_4	DBLBUF_EN_3	DBLBUF_EN_2	DBLBUF_EN_1	DBLBUF_EN_0	0	0	1	0	1	0	1	1	1	1
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h										R/W-AFh

**Table 69. Register R62 Field Descriptions**

Bit	Field	Type	Reset	Description
15	DBLBUF_EN_5	R/W	0h	Enables double buffering for the MASH order. 0: Disabled 1: Enabled
14	DBLBUF_EN_4	R/W	0h	Enables double buffering for fractional numerator NUM. 0: Disabled 1: Enabled
13	DBLBUF_EN_3	R/W	0h	Enables double buffering for the integer portion of the N-divider. 0: Disabled 1: Enabled
12	DBLBUF_EN_2	R/W	0h	Enables double buffering for the Pre-R and Post-R dividers in the reference path. Effective only if DBL_BUF_EN_3 = 1. 0: Disabled 1: Enabled
11	DBLBUF_EN_1	R/W	0h	Enables double buffering for the Multiplier in the reference path. Effective only if DBL_BUF_EN_3 = 1. 0: Disabled 1: Enabled
10	DBLBUF_EN_0	R/W	0h	Enables double buffering for the Doubler in the reference path. Effective only if DBL_BUF_EN_3 = 1. 0: Disabled 1: Enabled
9 - 0		R/W	AFh	Program AFh to this field.

**7.6.64 Register R63 (offset = 3Fh) [reset = 0000h]**
**Figure 91. Register R63**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 70. Register R63 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.65 Register R64 (offset = 40h) [reset = 1388h]**
**Figure 92. Register R64**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	1	0	0	1	1	1	0	0	0	1	0	0	0
R/W-1388h															

**Table 71. Register R64 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	1388h	Program 1388h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.66 Register R65 (offset = 41h) [reset = 0000h]**
**Figure 93. Register R65**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 72. Register R65 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.67 Register R66 (offset = 42h) [reset = 01F4h]**
**Figure 94. Register R66**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	1	1	1	1	1	0	1	0	0
R/W-1F4h															

**Table 73. Register R66 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	1F4h	Program 1F4h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.68 Register R67 (offset = 43h) [reset = 0000h]**
**Figure 95. Register R67**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 74. Register R67 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.69 Register R68 (offset = 44h) [reset = 03E8h]**
**Figure 96. Register R68**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	1	1	1	1	1	0	1	0	0	0
R/W-3E8h															

**Table 75. Register R68 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	3E8h	Program 3E8h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.70 Register R69 (offset = 45h) [reset = 0000h]**
**Figure 97. Register R69**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MASH_RST_COUNT[31:16]															
R/W-0h															

**Table 76. Register R69 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	MASH_RST_COUNT [31:16]	R/W	0h	Upper 16 bits of MASH_RST_COUNT. This register is used to add a delay when using phase SYNC. The delay should be set at least four times the PLL lock time. This delay is expressed in state machine clock periods. One of these periods is equal to $2^{CAL\_CLK\_DIV} / f_{OSCin}$ .

**7.6.71 Register R70 (offset = 46h) [reset = C350h]**
**Figure 98. Register R70**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MASH_RST_COUNT[15:0]															
R/W-C350h															

**Table 77. Register R70 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	MASH_RST_COUNT [15:0]	R/W	C350h	Lower 16 bits of MASH_RST_COUNT.

**7.6.72 Register R71 (offset = 47h) [reset = 0080h]**
**Figure 99. Register R71**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	1
R/W-80h															

**Table 78. Register R71 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	80h	Program 81h to this field.

**7.6.73 Register R72 (offset = 48h) [reset = 0001h]**
**Figure 100. Register R72**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
R/W-1h															

**Table 79. Register R72 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	1h	Program 1h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.74 Register R73 (offset = 49h) [reset = 003Fh]**
**Figure 101. Register R73**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
R/W-3Fh															

**Table 80. Register R73 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	3Fh	Program 3Fh to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.75 Register R74 (offset = 4Ah) [reset = 0000h]**
**Figure 102. Register R74**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 81. Register R74 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.76 Register R75 (offset = 4Bh) [reset = 0800h]**
**Figure 103. Register R75**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
0	0	0	0	1	CHDIV						0	0	0	0	0	0
R/W-1h				R/W-0h						R/W-0h						

**Table 82. Register R75 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 11		R/W	1h	Program 1h to this field.
10 - 6	CHDIV	R/W	0h	Channel divider. 0: Divide by 2 1: Divide by 4 3: Divide by 8 5: Divide by 16 7: Divide by 32 9: Divide by 64 12: Divide by 128 14: Divide by 256 All other values are not used.

**Table 82. Register R75 Field Descriptions (continued)**

Bit	Field	Type	Reset	Description
5 - 0		R/W	0h	Program 0h to this field.

**7.6.77 Register R76 (offset = 4Ch) [reset = 000Ch]**
**Figure 104. Register R76**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	0
R/W-Ch															

**Table 83. Register R76 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	Ch	Program Ch to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.78 Register R77 (offset = 4Dh) [reset = 0000h]**
**Figure 105. Register R77**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 84. Register R77 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.79 Register R78 (offset = 4Eh) [reset = 0064h]**
**Figure 106. Register R78**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	RAMP_THRESH[32]	0	QUICK_RECAL_EN	VCO_CAPCTRL_STRT								1
R/W-0h				R/W-0h	R/W-0h	R/W-0h	R/W-32h								R/W-0h

**Table 85. Register R78 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 12		R/W	0h	Program 0h to this field.
11	RAMP_THRESH[32]	R/W	0h	The 33 <sup>rd</sup> bit of RAMP_THRESH. RAMP_THRESH sets how much the ramp can change the VCO frequency before a VCO calibration is required. If the frequency is chosen to be $\Delta f$ , then $RAMP\_THRESH = (\Delta f / f_{PD}) \times 2^{24}$ .
10		R/W	0h	Program 0h to this field.
9	QUICK_RECAL_EN	R/W	0h	This sets the initial VCO starting calibration values. Especially useful if the frequency change is smaller, say < 50 MHz or so. 0: Calibration starts with VCO_SEL, VCO_CAPCTRL_START, VCO_DACISSET_START 1: Calibration starts with the current value
8 - 1	VCO_CAPCTRL_STRT	R/W	32h	This sets the starting VCO_CAPCTRL value that is used for VCO frequency calibration. Smaller values yield a higher frequency band within a VCO core. Valid number range is 0 to 183.
0		R/W	0h	Program 1h to this field.

**7.6.80 Register R79 (offset = 4Fh) [reset = 0000h]**

**Figure 107. Register R79**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_THRESH[31:16]															
R/W-0h															

**Table 86. Register R79 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	RAMP_THRESH[31:16]	R/W	0h	Upper 16 bits of RAMP_THRESH. See <a href="#">Table 85</a> for description.

**7.6.81 Register R80 (offset = 50h) [reset = 0000h]**

**Figure 108. Register R80**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_THRESH[15:0]															
R/W-0h															

**Table 87. Register R80 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	RAMP_THRESH[15:0]	R/W	0h	Lower 16 bits of RAMP_THRESH. See <a href="#">Table 85</a> for description.

**7.6.82 Register R81 (offset = 51h) [reset = 0000h]**

**Figure 109. Register R81**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															RAMP_LIMIT_HIGH[32]
R/W-0h															R/W-0h

**Table 88. Register R81 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 1		R/W	0h	Program 0h to this field.
0	RAMP_LIMIT_HIGH[32]	R/W	0h	The 33 <sup>rd</sup> bit of RAMP_LIMIT_HIGH. RAMP_LIMIT_HIGH sets a maximum frequency that the ramp cannot exceed so that the VCO does not get set beyond a valid frequency range. Suppose $f_{HIGH}$ is this frequency and $f_{VCO}$ is the starting VCO frequency, then: $f_{HIGH} \geq f_{VCO}$ ; $RAMP\_LIMIT\_HIGH = 2^{24} \times (f_{HIGH} - f_{VCO}) / f_{PD}$

**7.6.83 Register R82 (offset = 52h) [reset = 0000h]**

**Figure 110. Register R82**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_LIMIT_HIGH[31:16]															
R/W-0h															

**Table 89. Register R82 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	RAMP_LIMIT_HIGH [31:16]	R/W	0h	Upper 16 bits of RAMP_LIMIT_HIGH. See <a href="#">Table 88</a> for description.

**7.6.84 Register R83 (offset = 53h) [reset = 0000h]**
**Figure 111. Register R83**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_LIMIT_HIGH[15:0]															
R/W-0h															

**Table 90. Register R83 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	RAMP_LIMIT_HIGH[15:0]	R/W	0h	Lower 16 bits of RAMP_LIMIT_HIGH. See <a href="#">Table 88</a> for description.

**7.6.85 Register R84 (offset = 54h) [reset = 0000h]**
**Figure 112. Register R84**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															RAMP_L IMIT_LO W[32]
R/W-0h															R/W-0h

**Table 91. Register R84 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 1		R/W	0h	Program 0h to this field.
0	RAMP_LIMIT_LOW[32]	R/W	0h	The 33 <sup>rd</sup> bit of RAMP_LIMIT_LOW. RAMP_LIMIT_LOW sets a minimum frequency that the ramp cannot exceed so that the VCO does not get set beyond a valid frequency range. Suppose $f_{LOW}$ is this frequency and $f_{VCO}$ is the starting VCO frequency, then: $f_{LOW} \leq f_{VCO}$ ; $RAMP\_LIMIT\_LOW = 2^{33} - 2^{24} \times (f_{VCO} - f_{LOW}) / f_{PD}$

**7.6.86 Register R85 (offset = 55h) [reset = 0000h]**
**Figure 113. Register R85**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_LIMIT_LOW[31:16]															
R/W-0h															

**Table 92. Register R85 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	RAMP_LIMIT_LOW [31:16]	R/W	0h	Upper 16 bits of RAMP_LIMIT_LOW. See <a href="#">Table 91</a> for description.

**7.6.87 Register R86 (offset = 56h) [reset = 0000h]**
**Figure 114. Register R86**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_LIMIT_LOW[15:0]															
R/W-0h															

**Table 93. Register R86 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	RAMP_LIMIT_LOW[15:0]	R/W	0h	Lower 16 bits of RAMP_LIMIT_LOW. See <a href="#">Table 91</a> for description.

**7.6.88 Register R87 (offset = 57h) [reset = 0000h]**
**Figure 115. Register R87**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 94. Register R87 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.89 Register R88 (offset = 58h) [reset = 0000h]**
**Figure 116. Register R88**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 95. Register R88 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.90 Register R89 (offset = 59h) [reset = 0000h]**
**Figure 117. Register R89**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 96. Register R89 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.91 Register R90 (offset = 5Ah) [reset = 0000h]**
**Figure 118. Register R90**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 97. Register R90 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.92 Register R91 (offset = 5Bh) [reset = 0000h]**
**Figure 119. Register R91**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 98. Register R91 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.93 Register R92 (offset = 5Ch) [reset = 0000h]**
**Figure 120. Register R92**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 99. Register R92 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.94 Register R93 (offset = 5Dh) [reset = 0000h]**
**Figure 121. Register R93**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 100. Register R93 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.95 Register R94 (offset = 5Eh) [reset = 0000h]**
**Figure 122. Register R94**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 101. Register R94 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.96 Register R95 (offset = 5Fh) [reset = 0000h]**
**Figure 123. Register R95**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

**Table 102. Register R95 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	0h	Program 0h to this field. After programming R0 with RESET = 1, no need to program this register.

**7.6.97 Register R96 (offset = 60h) [reset = 0000h]**
**Figure 124. Register R96**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_BURST_COUNT														0	0
R/W-0h														R/W-0h	

**Table 103. Register R96 Field Descriptions**

Bit	Field	Type	Reset	Description
15	RAMP_BURST_EN	R/W	0h	This enables ramp burst mode. In this mode, a number of ramps equal to RAMP_BURST_COUNT is sent out whenever RAMP_EN is set to 1. This is intended to produce a finite pattern of ramps, instead of a continuous pattern. 0: Disabled 1: Enabled
14 - 2	RAMP_BURST_COUNT	R/W	0h	When RAMP_BURST_EN = 1, this sets the number of ramps that is sent out.
1 - 0		R/W	0h	Program 0h to this field.

**7.6.98 Register R97 (offset = 61h) [reset = 0000h]**
**Figure 125. Register R97**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
RAMP0_RST	0	0	0	0	RAMP_TRIGB				RAMP_TRIGA				0	RAMP_BURST_TRIG		
R/W-0h		R/W-0h			R/W-0h				R/W-0h				R/W-0h		R/W-0h	

**Table 104. Register R97 Field Descriptions**

Bit	Field	Type	Reset	Description
15	RAMP0_RST	R/W	0h	Resets RAMP0 at start of ramp to eliminate round-off errors. Applies to automatic ramping mode only. 0: Disabled 1: Reset
14 - 11		R/W	0h	Program 0h to this field.
10 - 7	RAMP_TRIGB	R/W	0h	Definition of ramp trigger B. 0: Disabled 1: RampClk pin rising edge 2: RampDir pin rising edge 4: Always triggered 9: RampClk pin falling edge 10: RampDir pin falling edge All other values are not used.
6 - 3	RAMP_TRIGA	R/W	0h	Definition of ramp trigger A. Options are same as RAMP_TRIGB.
2		R/W	0h	Program 0h to this field.
1 - 0	RAMP_BURST_TRIG	R/W	0h	Sets what triggers the next ramp in burst mode. 0: Ramp transition 1: Trigger A 2: Trigger B 3: Not used

**7.6.99 Register R98 (offset = 62h) [reset = 0000h]**
**Figure 126. Register R98**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP0_INC[29:16]														0	RAMP0_DLY
R/W-0h														R/W-0h	

**Table 105. Register R98 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 2	RAMP0_INC[29:16]	R/W	0h	Upper 14 bits of RAMP0_INC. RAMP0_INC sets the 2's compliment of the number added to the fractional numerator on every ramp cycle.
1		R/W	0h	Program 0h to this field.
0	RAMP0_DLY	R/W	0h	When enabled, increases RAMP0 length by basing the ramp clock on two phase detector cycles instead of one. 0: Ramp clock = 1 f <sub>PD</sub> cycle 1: Ramp clock = 2 f <sub>PD</sub> cycles

**7.6.100 Register R99 (offset = 63h) [reset = 0000h]**
**Figure 127. Register R99**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP0_INC[15:0]															
R/W-0h															

**Table 106. Register R99 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	RAMP0_INC[15:0]	R/W	0h	Lower 16 bits of RAMP0_INC. See <a href="#">Table 105</a> for description.

**7.6.101 Register R100 (offset = 64h) [reset = 0000h]**
**Figure 128. Register R100**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP0_LEN															
R/W-0h															

**Table 107. Register R100 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	RAMP0_LEN	R/W	0h	Length of the ramp in phase detector cycles.

**7.6.102 Register R101 (offset = 65h) [reset = 0000h]**
**Figure 129. Register R101**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	RAMP1_DLY	RAMP1_RST	RAMP0_NEXT	0	0	RAMP0_NEXT_TRIG	
R/W-0h									R/W-0h	R/W-0h	R/W-0h	R/W-0h		R/W-0h	

**Table 108. Register R101 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 7		R/W	0h	Program 0h to this field.
6	RAMP1_DLY	R/W	0h	When enabled, increases RAMP1 length by basing the ramp clock on two phase detector cycles instead of one. 0: Ramp clock = 1 f <sub>PD</sub> cycle 1: Ramp clock = 2 f <sub>PD</sub> cycles
5	RAMP1_RST	R/W	0h	Resets RAMP1 at start of ramp to eliminate round-off errors. Applies to automatic ramping mode only. 0: Disabled 1: Reset
4	RAMP0_NEXT	R/W	0h	Defines what ramp comes after RAMP0. 0: RAMP0 1: RAMP1

**Table 108. Register R101 Field Descriptions (continued)**

Bit	Field	Type	Reset	Description
3 - 2		R/W	0h	Program 0h to this field.
1 - 0	RAMP0_NEXT_TRIG	R/W	0h	Defines what triggers the next ramp. 0: RAMP0_LEN timeout counter 1: Trigger A 2: Trigger B 3: Not used

**7.6.103 Register R102 (offset = 66h) [reset = 0000h]**
**Figure 130. Register R102**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	RAMP1_INC[29:16]													
R/W-0h															

**Table 109. Register R102 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 14		R/W	0h	Program 0h to this field.
13 - 0	RAMP1_INC[29:16]	R/W	0h	Upper 14 bits of RAMP1_INC. RAMP1_INC sets the 2's compliment of the number added to the fractional numerator on every ramp cycle.

**7.6.104 Register R103 (offset = 67h) [reset = 0000h]**
**Figure 131. Register R103**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP1_INC[15:0]															
R/W-0h															

**Table 110. Register R103 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	RAMP1_INC[15:0]	R/W	0h	Lower 16 bits of RAMP1_INC. See <a href="#">Table 109</a> for description.

**7.6.105 Register R104 (offset = 68h) [reset = 0000h]**
**Figure 132. Register R104**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP1_LEN															
R/W-0h															

**Table 111. Register R104 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	RAMP1_LEN	R/W	0h	Length of the ramp in phase detector cycles.

**7.6.106 Register R105 (offset = 69h) [reset = 4440h]**
**Figure 133. Register R105**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_DLY_CNT										RAMP_MANUAL	RAMP1_NEXT	0	0	RAMP1_NEXT_TRIG	
R/W-111h										R/W-0h	R/W-0h	R/W-0h		R/W-0h	

**Table 112. Register R105 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 6	RAMP_DLY_CNT	R/W	111h	For ramping mode, RAMP_DLY_CNT and RAMP_SCALE_COUNT determine the minimum necessary time taken for VCO calibration during the ramp. Min. VCOCal time = $(1 / f_{smc}) / (RAMP\_DLY\_CNT \times 2^{RAMP\_SCALE\_COUNT})$ , where $f_{smc} = f_{OSCin} / 2^{CAL\_CLK\_DIV}$ .
5	RAMP_MANUAL	R/W	0h	Selects the ramping mode. 0: Automatic ramping mode 1: Manual (Pin) ramping mode
4	RAMP1_NEXT	R/W	0h	Defines what ramp comes after RAMP1. 0: RAMP0 1: RAMP1
3 - 2		R/W	0h	Program 0h to this field.
1 - 0	RAMP1_NEXT_TRIG	R/W	0h	Defines what triggers the next ramp. 0: RAMP1_LEN timeout counter 1: Trigger A 2: Trigger B 3: Not used

**7.6.107 Register R106 (offset = 6Ah) [reset = 0007h]**
**Figure 134. Register R106**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	RAMP_T RIG_CA L	0	RAMP_SCALE_COUNT		
R/W-0h											R/W-0h	R/W-0h	R/W-7h		

**Table 113. Register R106 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 5		R/W	0h	Program 0h to this field.
4	RAMP_TRIG_CAL	R/W	0h	Enabling this bit causes VCO calibration to occur in automatic ramping mode at the beginning of each ramp. 0: Disabled 1: Enabled
3		R/W	0h	Program 0h to this field.
2 - 0	RAMP_SCALE_COUNT	R/W	7h	For ramping mode, RAMP_DLY_CNT and RAMP_SCALE_COUNT determine the minimum necessary time taken for VCO calibration during the ramp. Min. VCOCal time = $(1 / f_{smc}) / (RAMP\_DLY\_CNT \times 2^{RAMP\_SCALE\_COUNT})$ , where $f_{smc} = f_{OSCin} / 2^{CAL\_CLK\_DIV}$ .

**7.6.108 Register R107 (offset = 6Bh) [reset = 0000h]**
**Figure 135. Register R107**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R-0h															

**Table 114. Register R107 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R	0h	Not used. (Read back only)

**7.6.109 Register R108 (offset = 6Ch) [reset = 0000h]**
**Figure 136. Register R108**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R-0h															

**Table 115. Register R108 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R	0h	Not used. (Read back only)

**7.6.110 Register R109 (offset = 6Dh) [reset = 0000h]**
**Figure 137. Register R109**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R-0h															

**Table 116. Register R109 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R	0h	Not used. (Read back only)

**7.6.111 Register R110 (offset = 6Eh) [reset = 0000h]**
**Figure 138. Register R110**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	rb_LD_VTUNE	0	rb_VCO_SEL		0	0	0	0	0	0	0
R-0h															

**Table 117. Register R110 Field Descriptions**

Bit	Field	Type	Reset	Description
10 - 9	rb_LD_VTUNE	R	0h	Readback of Vtune lock detect. 0: Unlocked 1: Unlocked 2: Locked 3: Invalid
7 - 5	rb_VCO_SEL	R	0h	Reads back the actual VCO that the calibration has selected. 1: VCO1 2: VCO2 ..... 6: VCO6 All other values are not used.

**7.6.112 Register R111 (offset = 6Fh) [reset = 0000h]**
**Figure 139. Register R111**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
0	0	0	0	0	0	0	0	rb_VCO_CAPCTRL								0
R-0h																

**Table 118. Register R111 Field Descriptions**

Bit	Field	Type	Reset	Description
7 - 0	rb_VCO_CAPCTRL	R	0h	Reads back the actual CAPCTRL value that the VCO calibration has chosen.

**7.6.113 Register R112 (offset = 70h) [reset = 0000h]**
**Figure 140. Register R112**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	rb_VCO_DACISSET								
R-0h															

**Table 119. Register R112 Field Descriptions**

Bit	Field	Type	Reset	Description
8 - 0	rb_VCO_DACISSET	R	0h	Reads back the actual DACISSET value that the VCO calibration has chosen.

**7.6.114 Register R113 (offset = 71h) [reset = 0000h]**
**Figure 141. Register R113**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R-0h															

**Table 120. Register R113 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R	0h	Not used. (Read back only)

**7.6.115 Register R114 (offset = 72h) [reset = 7800h]**
**Figure 142. Register R114**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	1	1	1	FSK_EN	0	FSK_I2S _FS_PO L	FSK_I2S _CLK_P OL	FSK_SPI_LEVEL	FSK_SPI_DEV_SEL			FSK_MODE_SEL		
R/W-Fh				R/W-0h		R/W-0h	R/W-0h	R/W-0h	R/W-0h			R/W-0h			

**Table 121. Register R114 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 11		R/W	Fh	Program Fh to this field.
10	FSK_EN	R/W	0h	Enables all FSK modes. 0: Disabled 1: Enabled
9		R/W	0h	Program 0h to this filed.
8	FSK_I2S_FS_POL	R/W	0h	Sets the polarity of the I2S Frame Sync input in FSK I2S mode. 0: Active HIGH 1: Active LOW
7	FSK_I2S_CLK_POL	R/W	0h	Sets the polarity of the I2S CLK input in FSK I2S mode. 0: Rising edge 1: Falling edge
6 - 5	FSK_SPI_LEVEL	R/W	0h	Defines the desired FSK level in FSK SPI mode. When this bit is zero, FSK operation in this mode is disabled even if FSK_EN = 1. 0: Disabled 1: 2FSK 2: 4FSK 3: 8FSK
4 - 2	FSK_SPI_DEV_SEL	R/W	0h	In FSK SPI mode, these bits select one of the FSK deviations as defined in registers R116 - R123. 0: FSK_DEV0 1: FSK_DEV1 ..... 7: FSK_DEV7

**Table 121. Register R114 Field Descriptions (continued)**

Bit	Field	Type	Reset	Description
1 - 0	FSK_MODE_SEL	R/W	0h	Defines FSK mode. 0: Not used 1: FSK I2S 2: FSK SPI 3: FSK SPI FAST

**7.6.116 Register R115 (offset = 73h) [reset = 0000h]**
**Figure 143. Register R115**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	FSK_DEV_SCALE				0	0	0	
R/W-0h								R/W-0h				R/W-0h			

**Table 122. Register R115 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 8		R/W	0h	Program 0h to this field.
7 - 3	FSK_DEV_SCALE	R/W	0h	The FSK deviation will be scaled by $2^{\text{FSK\_DEV\_SCALE}}$ .
2 - 0		R/W	0h	Program 0h to this field.

**7.6.117 Register R116 (offset = 74h) [reset = 0000h]**
**Figure 144. Register R116**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FSK_DEV0															
R/W-0h															

**Table 123. Register R116 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	FSK_DEV0	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

**7.6.118 Register R117 (offset = 75h) [reset = 0000h]**
**Figure 145. Register R117**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FSK_DEV1															
R/W-0h															

**Table 124. Register R117 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	FSK_DEV1	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

**7.6.119 Register R118 (offset = 76h) [reset = 0000h]**
**Figure 146. Register R118**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FSK_DEV2															
R/W-0h															

**Table 125. Register R118 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	FSK_DEV2	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

**7.6.120 Register R119 (offset = 77h) [reset = 0000h]**
**Figure 147. Register R119**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FSK_DEV3															
R/W-0h															

**Table 126. Register R119 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	FSK_DEV3	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

**7.6.121 Register R120 (offset = 78h) [reset = 0000h]**
**Figure 148. Register R120**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FSK_DEV4															
R/W-0h															

**Table 127. Register R120 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	FSK_DEV4	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

**7.6.122 Register R121 (offset = 79h) [reset = 0000h]**
**Figure 149. Register R121**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FSK_DEV5															
R/W-0h															

**Table 128. Register R121 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	FSK_DEV5	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

**7.6.123 Register R122 (offset = 7Ah) [reset = 0000h]**
**Figure 150. Register R122**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FSK_DEV6															
R/W-0h															

**Table 129. Register R122 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	FSK_DEV6	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

**7.6.124 Register R123 (offset = 7Bh) [reset = 0000h]**
**Figure 151. Register R123**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FSK_DEV7															
R/W-0h															

**Table 130. Register R123 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	FSK_DEV7	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

**7.6.125 Register R124 (offset = 7Ch) [reset = 0000h]**
**Figure 152. Register R124**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FSK_SPI_FAST_DEV															
R/W-0h															

**Table 131. Register R124 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0	FSK_SPI_FAST_DEV	R/W	0h	Defines the desired frequency deviation in FSK SPI FAST mode.

**7.6.126 Register R125 (offset = 7Dh) [reset = 0820h]**
**Figure 153. Register R125**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	0	0	0	0	0	1	0	0	0	0	0
R/W-0820h															

**Table 132. Register R125 Field Descriptions**

Bit	Field	Type	Reset	Description
15 - 0		R/W	820h	Program 820h to this field. After programming R0 with RESET = 1, no need to program this register.

## 8 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

#### 8.1.1 OSCin Configuration

OSCin supports single-ended and differential clock. Register R5 defines OSCin configuration.

Table 133. OSCin Configuration

OSCin TYPE	SINGLE-ENDED CLOCK	DIFFERENTIAL CLOCK
Configuration Diagram		
Register Setting	IPBUF_TYPE = 1	IPBUF_TYPE = 0 IPBUF_TERM = 1

Single-ended and differential input clock definitions are shown in Figure 154.

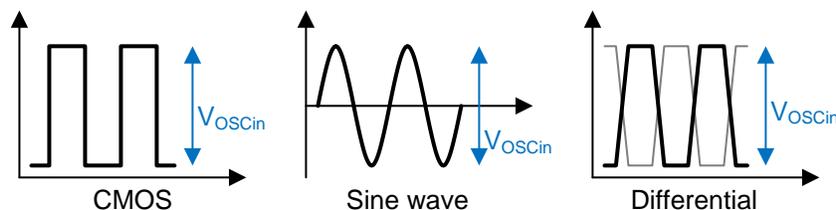


Figure 154. Input Clock Definition

#### 8.1.2 OSCin Slew Rate

The slew rate of the OSCin signal can have an impact on the spurs and phase noise of the LMX2572LP if it is too low. In general, the best performance is for a high slew rate but a lower amplitude signal, such as LVDS.

#### 8.1.3 VCO Gain

The VCO gain varies between the six VCO cores and is the lowest at the lowest end of the band and highest at the highest end of each band. The typical VCO gain over each VCO core is listed in Table 134.

Table 134. VCO Gain

VCO CORE	f <sub>Min</sub> (MHz)	f <sub>Max</sub> (MHz)	K <sub>VcoMin</sub> (MHz/V)	K <sub>VcoMax</sub> (MHz/V)
VCO1	3200	3650	32	47
VCO2	3650	4200	35	54
VCO3	4200	4650	47	64
VCO4	4650	5200	50	73
VCO5	5200	5750	61	82
VCO6	5750	6400	57	79

For an arbitrary VCO frequency, the VCO gain can be estimated as [Equation 4](#):

$$K_{VCO} = K_{VCO\text{Min}} + (K_{VCO\text{Max}} - K_{VCO\text{Min}}) \times (f_{VCO} - f_{\text{Min}}) / (f_{\text{Max}} - f_{\text{Min}}) \quad (4)$$

### 8.1.4 VCO Calibration

The purpose of VCO calibration is to find out: (1) the correct VCO core, (2) the best band within the core, and (3) the best VCO amplitude setting. The LMX2572LP allows the user to assist the VCO calibration. In general, there are three kinds of assistance.

#### 8.1.4.1 Partial Assist

Upon every frequency change, before the FCAL\_EN bit is checked, the user provides a good estimate of the initial starting point for the VCO core (VCO\_SEL), band (VCO\_CAPCTRL\_STRT), and amplitude (VCO\_DACISSET\_STRT). To do the partial assist for the VCO calibration, follow this procedure:

1. Pick a VCO core that includes the desired VCO frequency. If at the boundary of two cores, choose based on phase noise or performance.
2. Use [Equation 5](#) to find the approximate band:

$$VCO\_CAPCTRL\_STRT = \text{Round}[C_{\text{Min}} - (f_{VCO} - f_{\text{Min}}) \times (C_{\text{Min}} - C_{\text{Max}}) / (f_{\text{Max}} - f_{\text{Min}})] \quad (5)$$

3. Use [Equation 6](#) to find the approximate amplitude setting.

$$VCO\_DACISSET\_STRT = \text{Round}[A_{\text{Min}} - (f_{VCO} - f_{\text{Min}}) \times (A_{\text{Min}} - A_{\text{Max}}) / (f_{\text{Max}} - f_{\text{Min}})] \quad (6)$$

**Table 135. VCO Core Parametric**

VCO CORE	f <sub>Min</sub> (MHz)	f <sub>Max</sub> (MHz)	C <sub>Min</sub>	C <sub>Max</sub>	A <sub>Min</sub>	A <sub>Max</sub>
VCO1	3200	3650	131	19	138	137
VCO2	3650	4200	143	25	162	142
VCO3	4200	4650	135	34	126	114
VCO4	4650	5200	136	25	195	172
VCO5	5200	5750	133	20	190	163
VCO6	5750	6400	151	27	256	204

#### 8.1.4.2 Close Frequency Assist

Upon initialization of the device, the user enables the QUICK\_RECAL\_EN bit. The next VCO calibration will use the current VCO core, band, and amplitude settings as the initial starting point. This approach is useful if the frequency change is small, say 50 MHz or so.

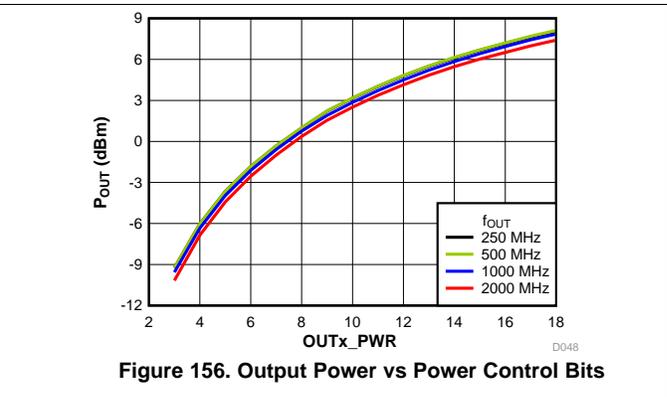
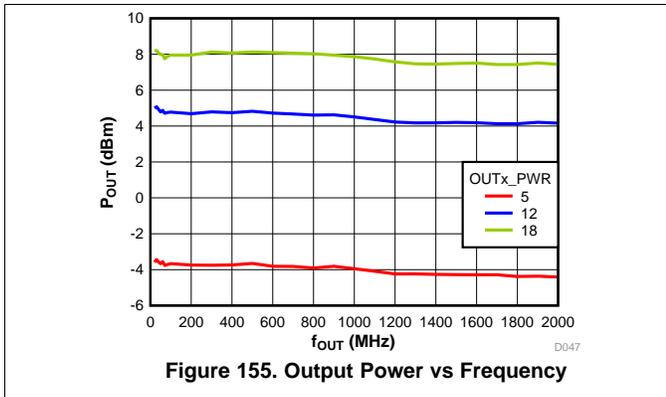
#### 8.1.4.3 Full Assist

The user forces the VCO core (VCO\_SEL), band (VCO\_CAPCTRL), and amplitude (VCO\_DACISSET) and manually sets the value. No VCO calibration will be performed. To force the set values, set VCO\_SEL\_FORCE, VCO\_CAPCTRL\_FORCE, and VCO\_DACISSET\_FORCE equal 1. First do a VCO calibration and then read back the values to obtain the set values.

### 8.1.5 Output Buffer Control

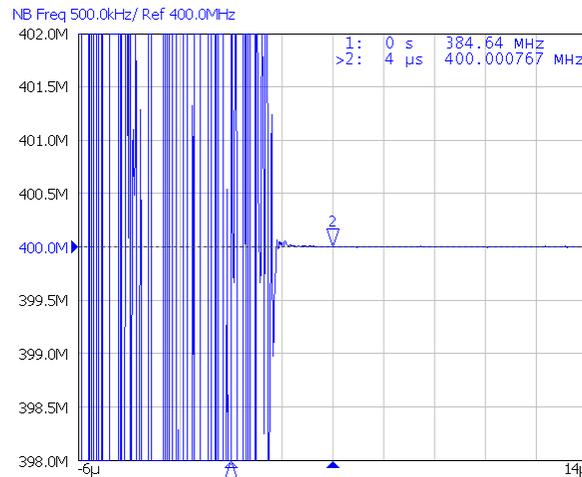
#### 8.1.5.1 Output Power

The OUTA\_PWR and OUTB\_PWR registers can be used to control the output power of the output buffers. Values greater than 18 are prohibited.



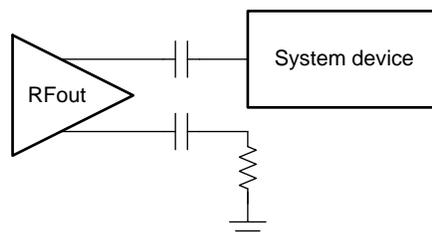
### 8.1.5.2 Power-Up Response

Use the OUTx\_PD bits to power up or power down the output buffers. The RF output will vanish immediately when the buffer is powered down. However, it takes some tiny amount of time for it to power up.



### 8.1.5.3 Unused Output Pin

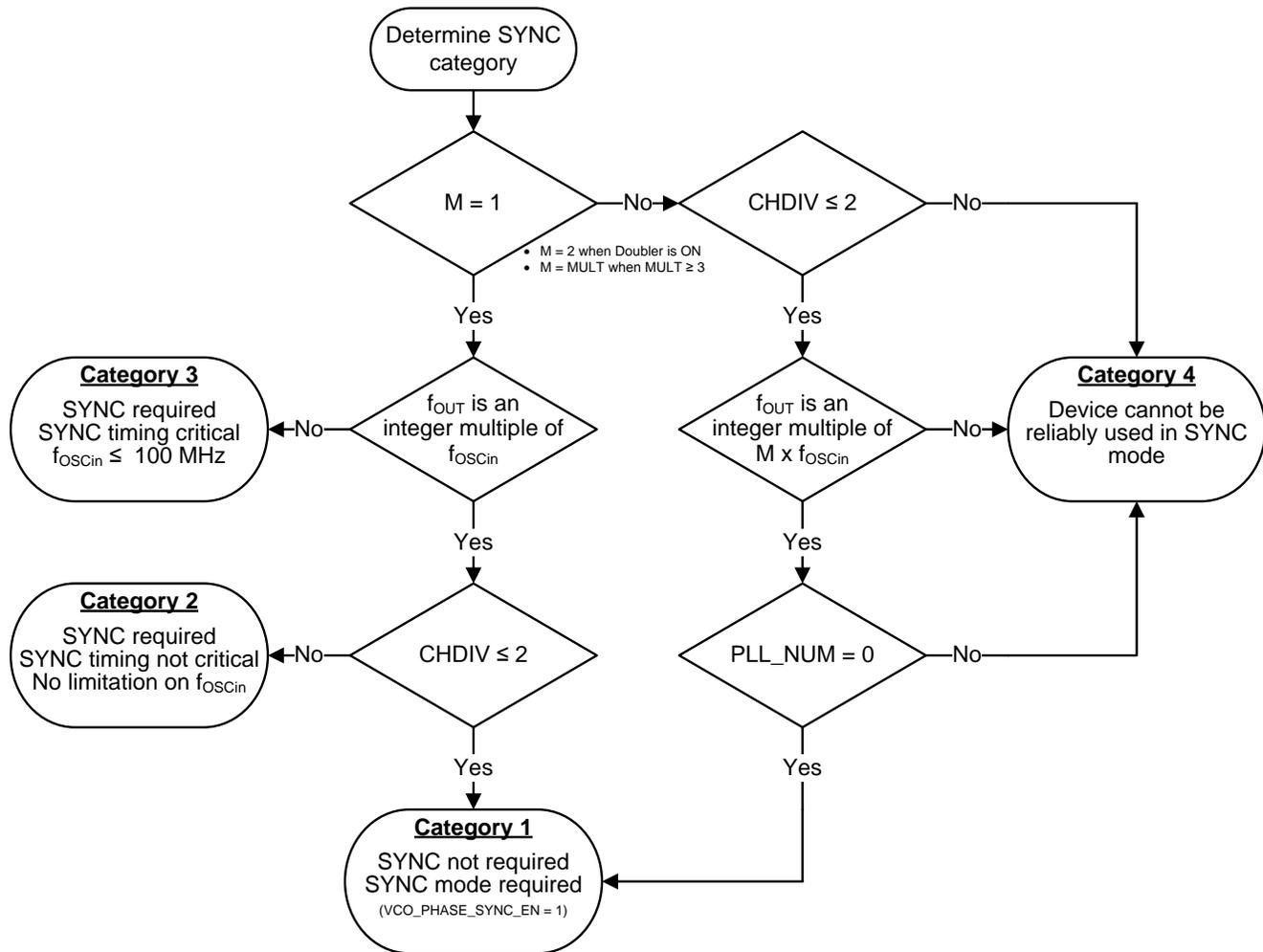
Each output buffer has two differential pair pins. The buffer can be used as a single differential output or two single-ended outputs. If only one single-ended output is necessary, the unused pin cannot be left open. The pin should be terminated properly as shown in Figure 158.



**Figure 158. Unused Output Buffer Differential Pin**

### 8.1.6 Application for SYNC

The requirements for SYNC depend on certain setup conditions. In cases where the SYNC is not timing critical, the setup can be done through software by toggling the VCO\_PHASE\_SYNC\_EN bit from 0 to 1. When the SYNC is timing critical, then setup must be done through the SYNC pin and the setup and hold times for the OSCin pin are critical.


**Figure 159. SYNC Category**

The procedure for using SYNC in different SYNC categories is shown in [Table 136](#).

**Table 136. Procedure for Using SYNC**

CATEGORY	CHARACTERISTIC	SETUP PROCEDURE
1	<ul style="list-style-type: none"> <li>• SYNC not required.</li> <li>• SYNC mode required.</li> </ul>	<ol style="list-style-type: none"> <li>1. Set <math>N = N' / 2</math>, where <math>N'</math> is the normal <math>N</math> divider value.</li> <li>2. Program all the registers with R0 VCO_PHASE_SYNC_EN = 1.</li> </ol>
2	<ul style="list-style-type: none"> <li>• SYNC required.</li> <li>• SYNC timing not critical.</li> <li>• No limitation on <math>f_{OSCin}</math>.</li> </ul>	<ol style="list-style-type: none"> <li>1. Setup as usual.</li> <li>2. Program all the registers as usual. The device is now locked.</li> <li>3. Program <math>N = N' / 2</math>, where <math>N'</math> is the normal (original) <math>N</math> divider value.</li> <li>4. Program R0 with VCO_PHASE_SYNC_EN = 1.</li> <li>5. Program <math>N = N'</math>.</li> <li>6. Program R0 with VCO_PHASE_SYNC_EN = 0.</li> <li>7. Alternatively, step 3 to 6 can be replaced by applying a SYNC signal (0 → 1 transition) to the SYNC pin and the timing on this is not critical.</li> </ol>

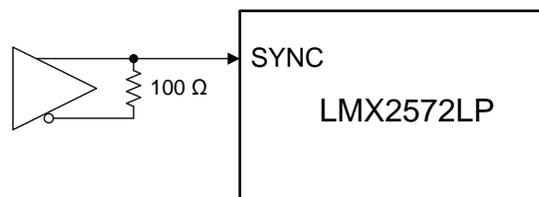
**Table 136. Procedure for Using SYNC (continued)**

CATEGORY	CHARACTERISTIC	SETUP PROCEDURE
3	<ul style="list-style-type: none"> <li>• SYNC required.</li> <li>• SYNC timing critical.</li> <li>• <math>f_{OSCin} \leq 100</math> MHz</li> </ul>	<ol style="list-style-type: none"> <li>1. Ensure that the maximum <math>f_{OSCin}</math> for SYNC is not violated and there are hardware accommodations to use the SYNC pin.</li> <li>2. Set <math>N = N' / 2</math>, where <math>N'</math> is the normal N divider (integer + fraction) value.</li> <li>3. Program all the registers with R0 VCO_PHASE_SYNC_EN = 1.</li> <li>4. Apply a SYNC signal (0 → 1 transition) to the SYNC pin. The timing of the SYNC signal as shown in Timing Requirements must be obey.</li> </ol>

Set these bits to drive the SYNC pin with a LVDS signal:

- Set INPIN\_FMT to 1 or 3 to enable LVDS input
- Set INPIN\_LVL to one of the options
- Set INPIN\_HYST, if necessary

The LVDS driver that is driving the SYNC pin should be configured as shown in [Figure 160](#):



**Figure 160. Driving SYNC Pin With Differential Signal**

### 8.1.7 Application for Ramp

#### 8.1.7.1 Manual Ramping Mode

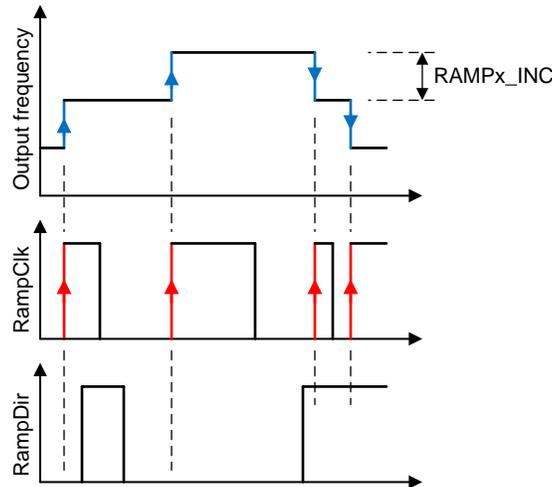
Manual ramping is enabled when the user sets RAMP\_EN = 1 and RAMP\_MANUAL = 1. In this mode, the ramp is clocked by the rising edges applied to the RampClk pin. The size of the frequency change is defined by RAMP0\_INC and RAMP1\_INC. If a LOW is seen at the RampDir pin on the rising edge of RampClk, the output frequency will be incremented by RAMP0\_INC. On the contrary, the output frequency will be incremented by RAMP1\_INC if a HIGH is captured. If a rising edge is seen on the RampClk pin while the VCO is calibrating, then this rising edge is ignored. The frequency for the RampClk must be limited to a frequency of 250 kHz or less, and the rising edge of the RampDir signal must be targeted to the falling edge of the RampClk pin. The necessary register fields for use in manual ramping mode are shown in [Table 137](#).

**Table 137. Manual Ramping Mode Programming**

REGISTER FIELD	VALUE	DESCRIPTION
RAMP_EN	1 = Enable ramp	Set this bit to 1 to enable frequency ramping.
RAMP_MANUAL	1 = Manual ramping mode	To select manual ramping mode, set this bit to 1.
RAMP_LIMIT_HIGH	Greater than the highest VCO ramp frequency	This sets the upper ramp limit that the ramp cannot go above. Suppose $f_{High}$ is this frequency and $f_{Start}$ is the starting VCO ramp frequency, then, for $f_{High} > f_{Start}$ , $RAMP\_LIMIT\_HIGH = 2^{24} \times (f_{High} - f_{Start}) / f_{PD}$
RAMP_LIMIT_LOW	Smaller than the lowest VCO ramp frequency	This sets the lower ramp limit that the ramp cannot go below. Suppose $f_{Low}$ is this frequency and $f_{Start}$ is the starting VCO ramp frequency, then, for $f_{Start} > f_{Low}$ , $RAMP\_LIMIT\_LOW = 2^{33} - 2^{24} \times (f_{Start} - f_{Low}) / f_{PD}$
RAMP0_INC RAMP1_INC	Equal to the ramp size	Suppose the ramp size is $\Delta f$ , then $RAMPx\_INC = (\Delta f / f_{PD}) \times 2^{24}$ or $2^{30} - (\Delta f / f_{PD}) \times 2^{24}$ if $\Delta f$ is a negative number.
RAMP_THRESH	Suggest less than 50 MHz	If the amount of frequency ramp exceeds this threshold, a VCO calibration will be initiated. For example, if the ramp size is 50 MHz while this threshold is 30 MHz, then VCO calibration will be executed every time it ramps. Suppose the threshold frequency is $f_{TH}$ , then $RAMP\_THRESH = (f_{TH} / f_{PD}) \times 2^{24}$

**Table 137. Manual Ramping Mode Programming (continued)**

REGISTER FIELD	VALUE	DESCRIPTION
RAMP_TRIGA RAMP_TRIGB	1 = RampClk rising edge trigger	In manual ramping mode, the ramp is triggered by the rising edges applied to the RampClk pin. Either RAMP_TRIGA or RAMP_TRIGB can be selected as the trigger source for the next ramp.
RAMP0_NEXT_TRIG RAMP1_NEXT_TRIG	Equal to the selected RAMP_TRIGx	These fields define what triggers the next ramp. They must be set to the same trigger source selected above.



**Figure 161. Manual Ramp Waveform**

**8.1.7.2 Automatic Ramping Mode**

Automatic ramping mode is enabled when RAMP\_EN = 1 with RAMP\_MANUAL = 0. In this mode, there are two ramps profiles that one can use to set the length and frequency change. In addition to this, there are ramp limits that can be used to create more complicated waveforms. The output frequency will ramp once on each phase detector cycle.

Automatic ramping can really be divided into two classes depending on whether the VCO must calibrate in the middle of the ramping or not. If the VCO can go the entire range without calibrating, this is calibration-free ramping. Note that this range is less at hot temperatures and less for lower frequency VCOs. This range is not ensured, so margin must be built into the design.

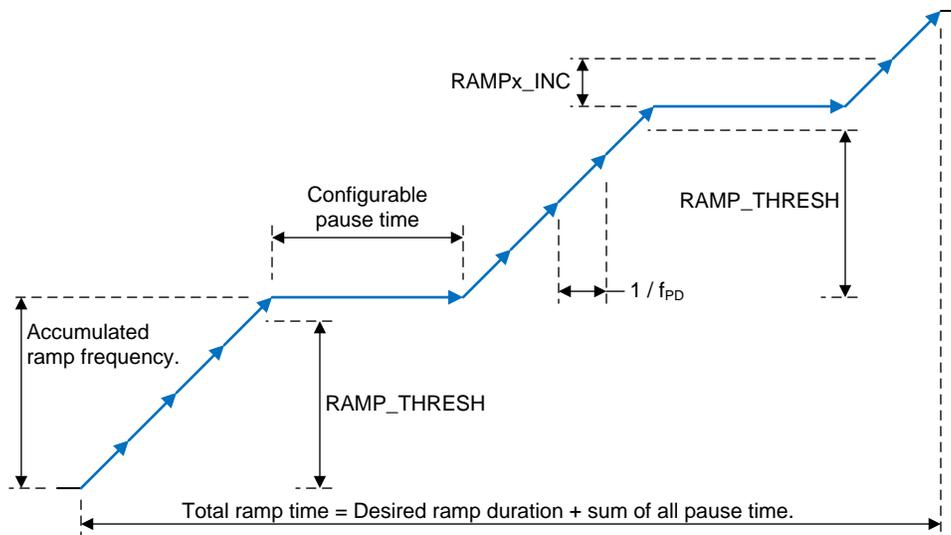
For ramping that are not calibration free, the ramp waveform is more like a staircase ramp.

**Table 138. Automatic Ramping Mode Programming**

REGISTER FIELD	VALUE	DESCRIPTION
RAMP_EN	1 = Enable ramp	Set this bit to 1 to enable frequency ramping.
RAMP_MANUAL	0 = Automatic ramping mode	To select automatic ramping mode, set this bit to 0.
RAMP_LIMIT_HIGH	Greater than the highest VCO ramp frequency	This sets the upper ramp limit that the ramp cannot go above. Suppose $f_{High}$ is this frequency and $f_{Start}$ is the starting VCO ramp frequency, then, for $f_{High} > f_{Start}$ , $RAMP\_LIMIT\_HIGH = 2^{24} \times (f_{High} - f_{Start}) / f_{PD}$
RAMP_LIMIT_LOW	Smaller than the lowest VCO ramp frequency	This sets the lower ramp limit that the ramp cannot go below. Suppose $f_{Low}$ is this frequency and $f_{Start}$ is the lowest VCO ramp frequency, then, for $f_{Start} > f_{Low}$ , $RAMP\_LIMIT\_LOW = 2^{33} - 2^{24} \times (f_{Start} - f_{Low}) / f_{PD}$
RAMP0_INC RAMP1_INC	Equal to the ramp size	Suppose the ramp size is $\Delta f$ , then $RAMPx\_INC = (\Delta f / f_{PD}) \times 2^{24}$ or $2^{30} - (\Delta f / f_{PD}) \times 2^{24}$ if $\Delta f$ is a negative number.
RAMP_THRESH	Suggest less than 50 MHz	If the amount of frequency ramp exceed this threshold, a VCO calibration will be initiated. For example, if the ramp size is 15 MHz while this threshold is 20 MHz, then VCO calibration will be executed every two ramps. Suppose the threshold frequency is $f_{TH}$ , then $RAMP\_THRESH = (f_{TH} / f_{PD}) \times 2^{24}$

**Table 138. Automatic Ramping Mode Programming (continued)**

REGISTER FIELD	VALUE	DESCRIPTION
RAMP0_LEN RAMP1_LEN	0 to 2 <sup>16</sup>	Set the number of ramp required in each ramp profile. Maximum value is 2 <sup>16</sup> . If this number is exceeded, enable the RAMPx_DLY bit or reduce the phase detector frequency. RAMPx_LEN = Ramp duration of a ramp profile × f <sub>PD</sub>
RAMP0_DLY RAMP1_DLY	0 or 1	If this bit is set to 1, the output frequency will ramp every two f <sub>PD</sub> cycles.
RAMP0_NEXT RAMP1_NEXT	Equal to the next ramp	Set the next ramping profile when the present profile is finished.
RAMP0_NEXT_TRIG RAMP1_NEXT_TRIG	0 = RAMP_LENx time out counter	Set these bits to 0 in order to start the next ramp immediately after the previous ramp.
RAMP0_RST RAMP1_RST	0 or 1	If the stop frequency of the present ramp profile is different from the start frequency of the next ramp profile, set this bit to 1.
RAMP_SCALE_COUNT RAMP_DLY_CNT	Suggest a minimum pause time of 50 μs	These two register fields set the minimum pause time when RAMP_THRESH is hit. This pause time must be sufficient to allow the VCO to complete a calibration, otherwise it will be overwritten by the actual VCO calibration time. Minimum pause time = RAMP_DLY_CNT × 2 <sup>RAMP_SCALE_COUNT</sup> × 2 <sup>CAL_CLK_DIV</sup> / f <sub>OSCin</sub>



**Figure 162. Auto Ramp Waveform**

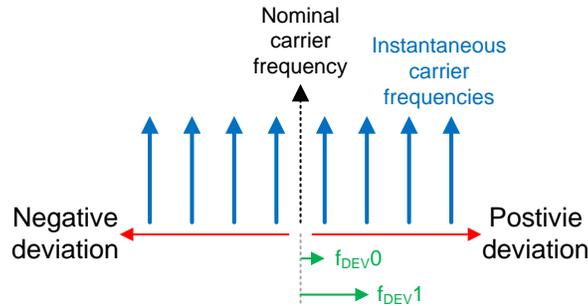
### 8.1.8 Application for FSK

In fractional mode, the finest delta frequency difference between two programmable output frequencies is equal to Equation 7:

$$f_1 - f_2 = \Delta f_{\min} = f_{PD} \times \left\{ \left[ \frac{PLL\_N + 1}{PLL\_DEN} \right] - \left[ \frac{PLL\_N}{PLL\_DEN} \right] \right\} = f_{PD} / PLL\_DEN \quad (7)$$

In other words, when the fractional numerator is incremented by 1 (one step), the output frequency will change by  $\Delta f_{\min}$ . A two steps increment will therefore change the frequency by  $2 \times \Delta f_{\min}$ .

In FSK operation, the instantaneous carrier frequency is kept changing among some pre-defined frequencies. In general, the instantaneous carrier frequency is defined as a certain frequency deviation from the nominal carrier frequency. The frequency deviation could be positive and negative.



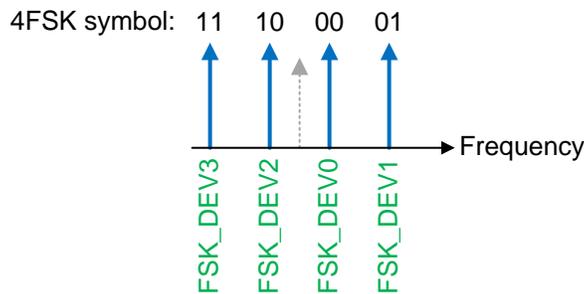
**Figure 163. General FSK Definition**

Equation 8 and Equation 9 define the number of steps required for the desired frequency deviation with respect to the nominal carrier frequency output. Assume  $\Delta f_{DEV}$  is the frequency deviation,

$$\text{For positive deviation, FSK step} = \text{Round}[(\Delta f_{DEV} \times \text{PLL\_DEN} \times \text{CHDIV}) / (f_{PD} \times 2^{\text{FSK\_DEV\_SCALE}})] \tag{8}$$

$$\text{For negative deviation, FSK step} = 2^{16} - \text{the positive deviation, FSK step answer} \tag{9}$$

In FSK SPI mode, registers R116 – R123 are used to store the desired FSK steps as defined in Equation 8 and Equation 9. The order of the registers, 0 to 7, depends on the application system. A typical 4FSK definition is shown in Figure 164. In this case, the FSK\_DEV0 and FSK\_DEV1 are calculated using Equation 8, while the FSK\_DEV2 and FSK\_DEV3 are calculated using Equation 9.



**Figure 164. Typical 4FSK Definition**

FSK SPI mode assumes the user knows which symbol to send. The user can directly write to FSK\_SPI\_DEV\_SEL to select the desired frequency deviation. For example, to enable the device to support 4FSK modulation in FSK SPI mode, set:

- FSK\_MODE\_SEL = 2 (FSK SPI)
- FSK\_SPI\_LEVEL = 2 (4FSK)
- FSK\_EN = 1

**Table 139. FSK SPI Mode Example**

DESIRED SYMBOL	WRITE REGISTER FSK_SPI_DEV_SEL	REGISTER SELECTED
10	2	FSK_DEV2
11	3	FSK_DEV3
10	2	FSK_DEV2
11	3	FSK_DEV3
01	1	FSK_DEV1
00	0	FSK_DEV0
...	...	...

FSK SPI mode supports up to eight levels of FSK. To support an arbitrary-level FSK, use FSK SPI FAST mode. Constructing pulse-shaping FSK modulation by over-sampling the FSK modulation waveform is one of the used cases of this mode.

Analog-FM modulation can also be produced in this mode. For example, with a 1-kHz sine wave modulation signal with peak frequency deviation of  $\pm 2$  kHz, the signal can be oversampled, say 10 times. Each sample point corresponding to a scaled frequency deviation.

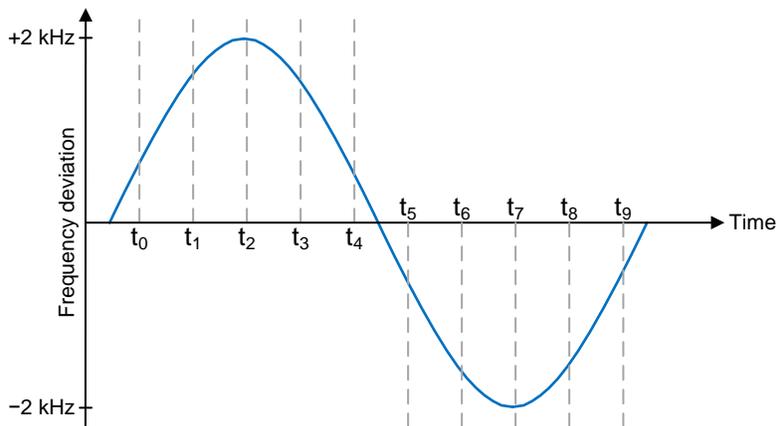


Figure 165. Oversampling Modulation Signal

In FSK SPI FAST mode, write the desired FSK steps directly to FSK\_SPI\_FAST\_DEV. To enable this mode, set:

- FSK\_MODE\_SEL = 3 (FSK SPI FAST)
- FSK\_EN = 1

Table 140. FSK SPI FAST Mode Example

TIME	FREQUENCY DEVIATION (Hz)	CORRESPONDING FSK STEPS <sup>(1)</sup>	BINARY EQUIVALENT	WRITE TO FSK_SPI_FAST_DEV
t <sub>0</sub>	618.034	396	0000 0001 1000 1100	396
t <sub>1</sub>	1618.034	1036	0000 0100 0000 1100	1036
t <sub>2</sub>	2000	1280	0000 0101 0000 0000	1280
...	...	...	...	...
t <sub>6</sub>	-1618.034	64500	1111 1011 1111 0011	64500
t <sub>7</sub>	-2000	64256	1111 1010 1111 1111	64256
...	...	...	...	...

(1) f<sub>VC0</sub> = 3840 MHz, f<sub>OUT</sub> = 480 MHz, f<sub>PD</sub> = 100 MHz, CHDIV = 8, PLL\_DEN = 8000000, FSK\_DEV\_SCALE = 0.

Block Programming is possible with FSK SPI FAST mode programming as long as ADD\_HOLD = 1, which will freeze the register address after the first register write. The same programming sequent as shown in Figure 27 applies.

In FSK I2S mode, clock in the desired binary format FSK steps in the I2S interface.

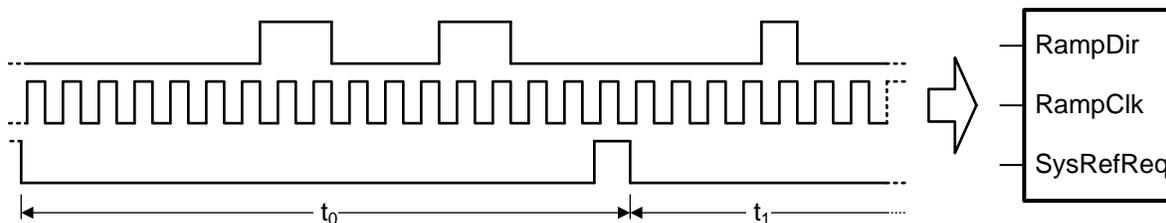


Figure 166. FSK I2S Mode Example

To enable FSK I2S mode, set

- INPIN\_IGNORE = 0
- FSK\_MODE\_SEL = 1 (FSK I2S)
- FSK\_EN = 1

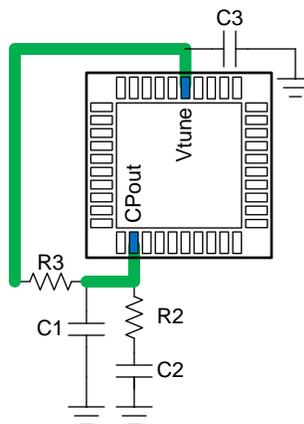
### 8.1.9 Unused Pins

TI recommends to pull these pins low if they are not used:

- Pin 5, SYNC
- Pin 28, SysRefReq
- Pin 30, RampClk
- Pin 32, RampDir

### 8.1.10 External Loop Filter

The LMX2572LP requires an external loop filter that is application-specific and can be configured by [PLLatinum Sim](#). For the LMX2572LP, it matters what impedance is seen from the Vtune pin looking outwards. This impedance is dominated by the component C3 for a third order filter or C1 for a second order filter. If there is at least 1.5 nF for the capacitance that is shunt with this pin, the VCO phase noise will be close to the best it can be. If there is less, the VCO phase noise in the 100-kHz to 1-MHz region will degrade. This capacitor should be placed close to the Vtune pin.



**Figure 167. External Loop Filter**

### 8.1.11 Power-Up, Wake-Up Time

When the device comes out of the powered-down state, either by resuming the POWERDOWN bit to zero or by pulling back CE pin HIGH (if it was powered down by CE pin), it takes time for the device to acquire lock again. This wake-up time depends on LDO\_DLY setting, loop bandwidth, and the state machine clock frequency ( $= f_{\text{OSCin}} / 2^{\text{CAL\_CLK\_DIV}}$ ). If the loop bandwidth is greater than 20 kHz, the wake-up time could be adjusted to less than 1.5 ms with the LDO\_DLY setting listed in [Table 141](#).

**Table 141. LDO\_DLY Setting**

STATE MACHINE CLOCK FREQUENCY	LDO_DLY
$130 \text{ MHz} \leq f \leq 200 \text{ MHz}$	8
$80 \text{ MHz} \leq f < 130 \text{ MHz}$	5
$50 \text{ MHz} \leq f < 80 \text{ MHz}$	3
$30 \text{ MHz} \leq f < 50 \text{ MHz}$	2
$f < 30 \text{ MHz}$	1

## 8.2 Typical Application

This application example demonstrates how to set up the LMX2572LP in FSK SPI FAST mode to synthesize 4-level GFSK modulation.

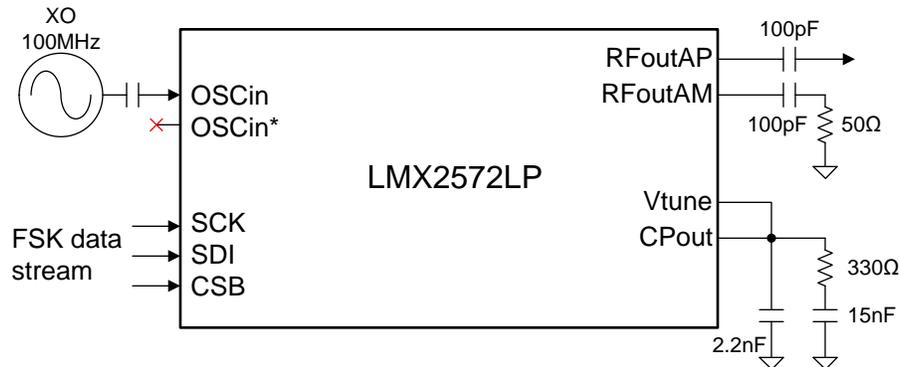


Figure 168. Application Example Schematic

### 8.2.1 Design Requirements

Table 142 lists the design parameters for this example.

Table 142. Design Parameters

PARAMETER	EXAMPLE VALUE
OSCin frequency	100 MHz
RFout frequency	490 MHz
4FSK modulation baud rate	125 kSps
BT of Gaussian filter	0.4
FSK frequency deviation	$\pm 17$ kHz and $\pm 51$ kHz
Fractional denominator	8000000

### 8.2.2 Detailed Design Procedure

First, determine all the elementary blocks of a synthesizer.

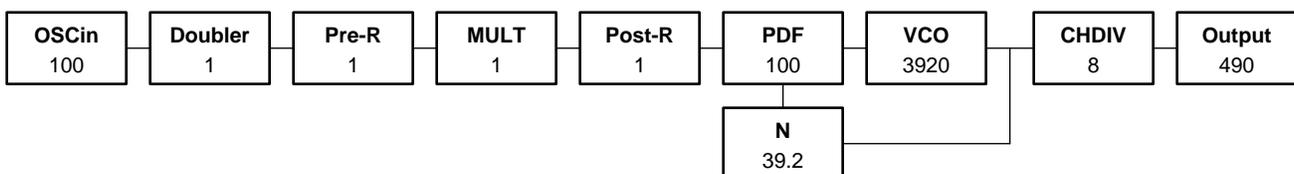


Figure 169. Application Example Frequency Plan

Then, program these registers to make LMX2572LP locks to the target output frequency:

- OSC\_2X = 0
- PLL\_R\_PRE = 1
- MULT = 1
- PLL\_R = 1
- PLL\_N[18:16] = 0; PLL\_N[15:0] = 39
- PLL\_NUM[31:16] = 24; PLL\_NUM[15:0] = 27136
- PLL\_DEN[31:16] = 122; PLL\_DEN[15:0] = 4680
- CHDIV = 8

Then program these registers to enable FSK SPI FAST mode:

- FSK\_MODE\_SEL = 3

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- FSK\_DEV\_SCALE = 1
- FSK\_EN = 1

A Matlab script is then developed to generate the necessary codes that will be used to continuously bit-stream the LMX2572LP. These codes are uploaded to the data generator DG2020, which will generate the SPI data to modulate the LMX2572LP.

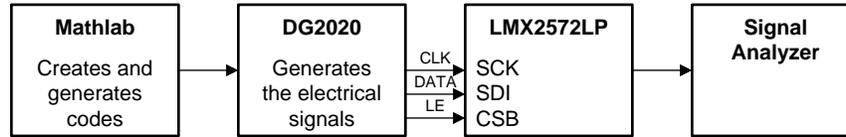
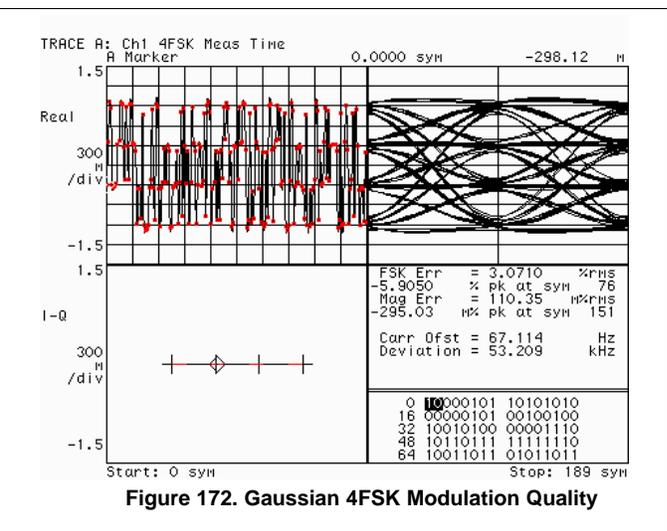
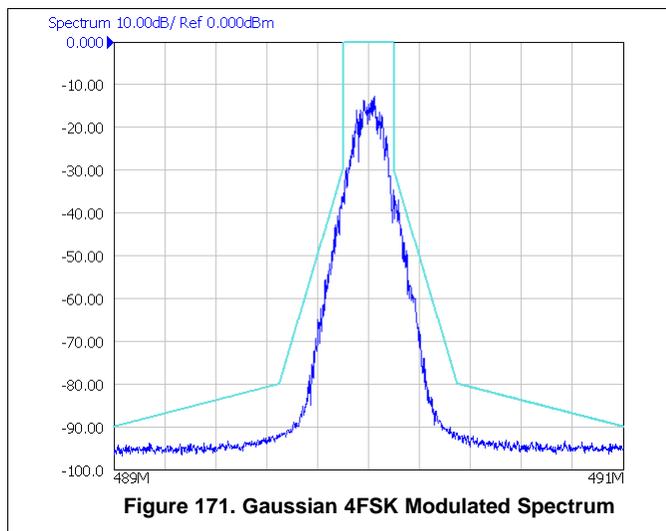


Figure 170. Application Example Test Setup

## 8.2.3 Application Curves



## 8.3 Do's and Don'ts

- RFout output buffers do not need an external pullup. An AC-couple to the load is good enough.
- The last shunt capacitor of the loop filter should be placed close to the Vtune pin.

Do's and Don'ts (continued)

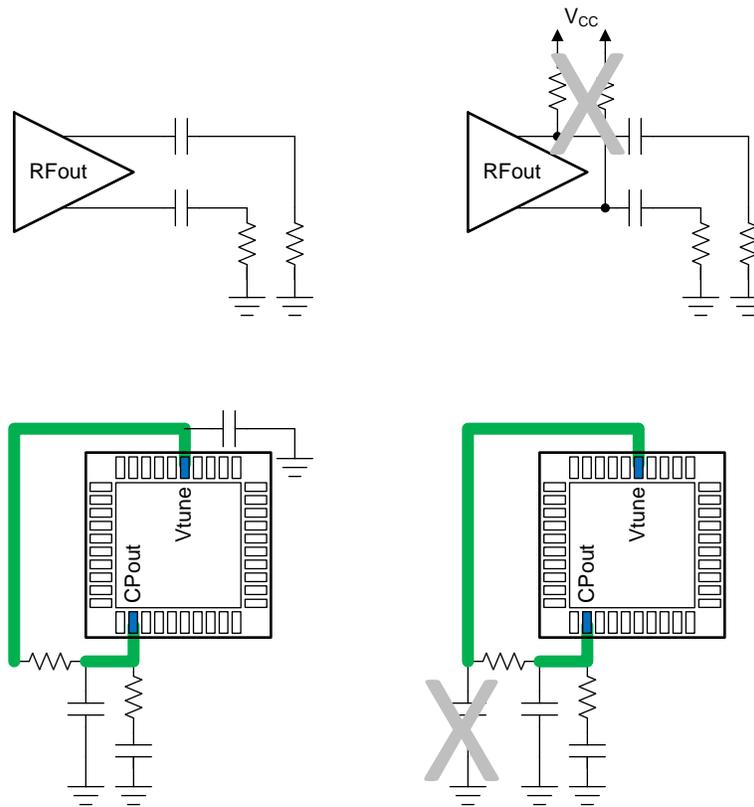


Figure 173. Do's and Don'ts

## 9 Power Supply Recommendations

TI recommends placing a 100-nF capacitor close to each of the power supply pins. If fractional spurs are a large concern, use a ferrite bead to each of these power supply pins to reduce spurs to a small degree. This device has integrated LDOs, which improves the resistance to power supply noise. [Figure 174](#) is a typical application example.

This device can be powered by an external DC/DC buck converter, such as the TPS62150. Note that although Rtps1 and Rtps2 are 1.5 Ω in the schematic, they could be potentially replaced with a larger resistor value or inductor value for better power supply filtering. Alternatively, the use of a larger capacitance value for C2 and C4 could also result in better power supply filtering.

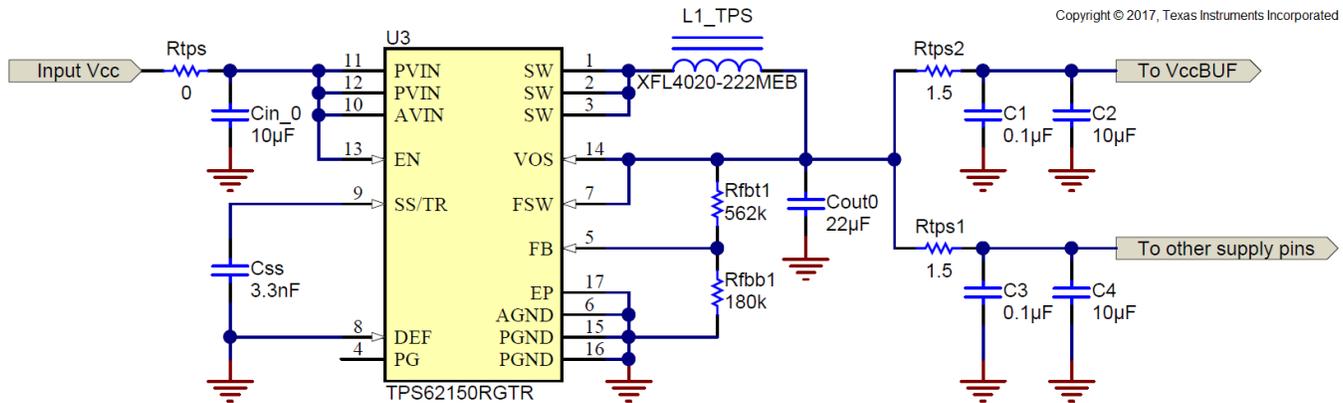


Figure 174. Power Supply With a DC/DC Converter

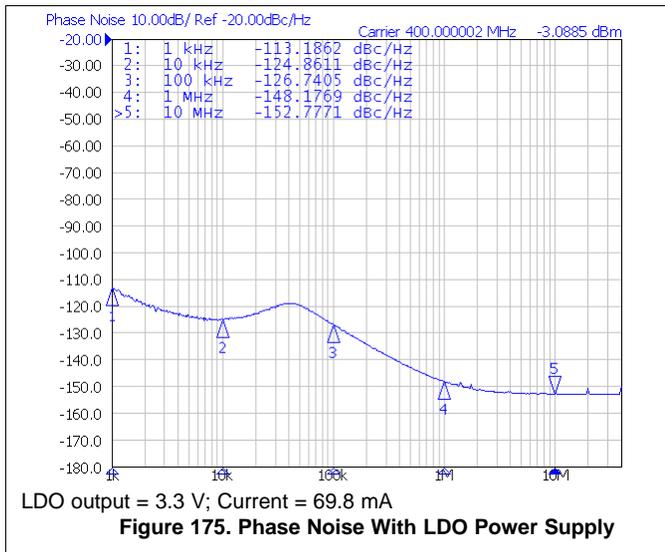


Figure 175. Phase Noise With LDO Power Supply

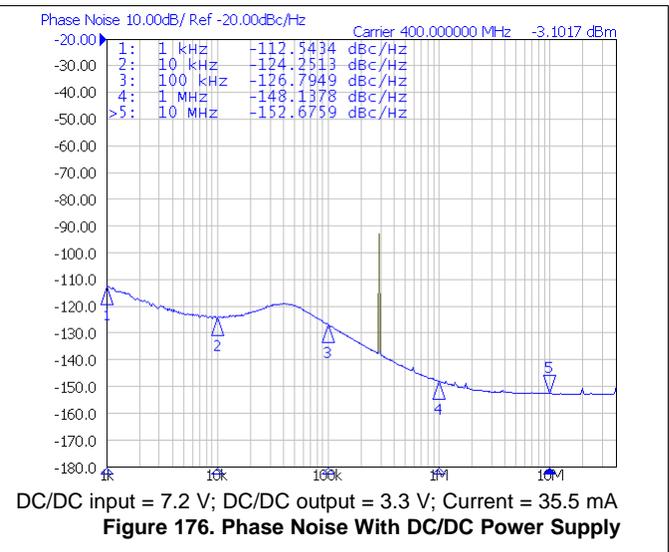


Figure 176. Phase Noise With DC/DC Power Supply

The power consumption of LMX2572LP depends on its configuration. The data as shown in the [Electrical Characteristics](#) table represent the current consumption at some specific conditions. It is possible to get a smaller or higher current consumption than what is specified in the data sheet. To get a rough estimation on current consumption at a particular configuration, use [TICS Pro](#).

## 10 Layout

### 10.1 Layout Guidelines

In general, the layout guidelines are similar to most other PLL devices. Here are some specific guidelines:

- GND pins may be routed on the package back to the DAP.
- The OSCin pins are internally biased and must be AC-coupled.
- The RampClk, RampDir, and SysRefReq can be grounded to the DAP if not used.
- Get a loop filter capacitor as close to the Vtune pin as possible to this. This may mean separating it from the rest of the loop filter.
- If a single-ended output is necessary, the other side must have the same loading. However, the routing for the used side can be optimized by routing the complementary side through a via to the other side of the board. On this side, make the load look equivalent to the side that is used.
- Ensure the DAP on the device is well-grounded with many vias, preferably copper filled.
- Have a thermal pad that is as large as the exposed pad. Add vias to the thermal pad to maximize thermal performance.

### 10.2 Layout Example

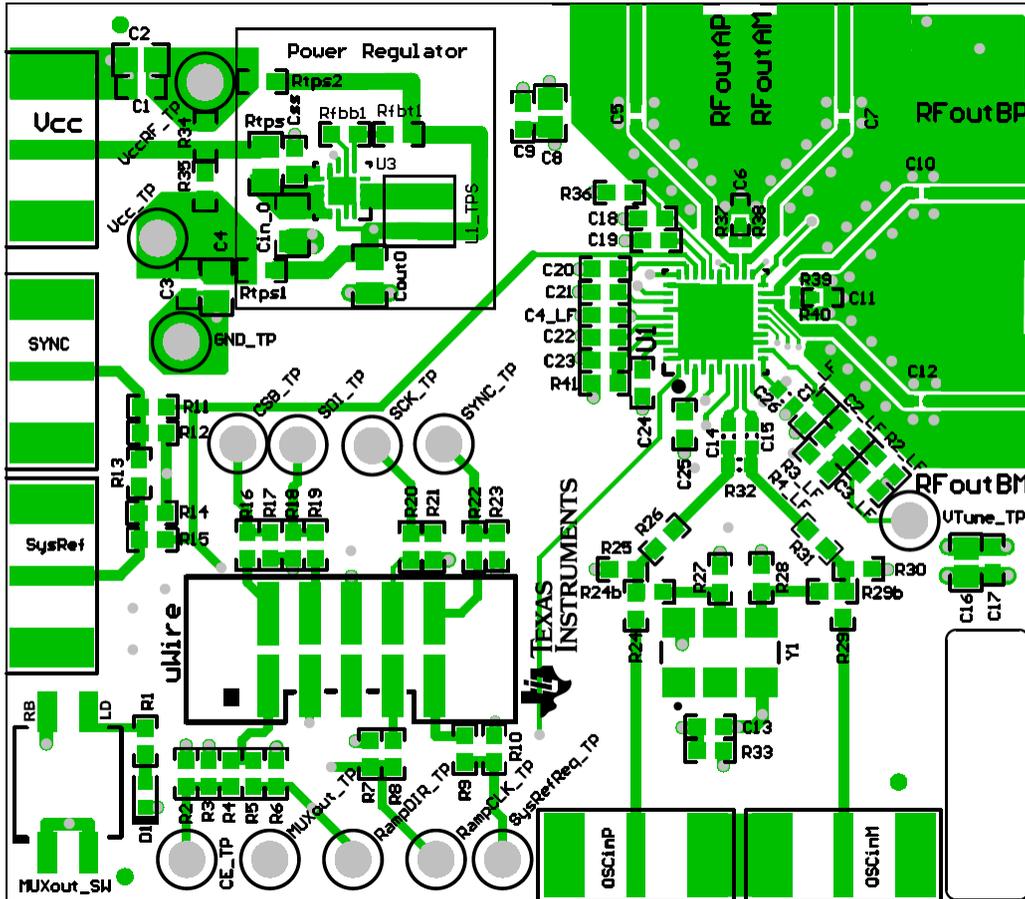


Figure 177. Layout Example

## 11 Device and Documentation Support

### 11.1 Device Support

#### 11.1.1 Development Support

Texas Instruments has several software tools to aid in the development at [www.ti.com](http://www.ti.com). Among these tools are:

- [PLLatinum Sim](#) program for designing loop filters, simulating phase noise and spurs.
- [TICS Pro](#) software to understand how to program the device and for programming the EVM board.

### 11.2 Documentation Support

#### 11.2.1 Related Documentation

For related documentation see the following:

- [TPS62150 3–17V 1A Step-Down Converter With DCS-Control](#) (SLVSAL5)
- [AN-1879 Fractional N Frequency Synthesis](#) (SNAA062)
- [Frequency Shift Keying With LMX2571](#) (SNAA309)
- [PLL Performance, Simulation, and Design Handbook](#) (SNAA106)
- [LMX2572LPEVM User's Guide](#) (SNAU235)

### 11.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 11.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 11.5 Trademarks

E2E is a trademark of Texas Instruments.  
All other trademarks are the property of their respective owners.

### 11.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 11.7 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LMX2572LPRHAR	ACTIVE	VQFN	RHA	40	2500	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	LMX2572 LP	
LMX2572LPRHAT	ACTIVE	VQFN	RHA	40	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	LMX2572 LP	

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

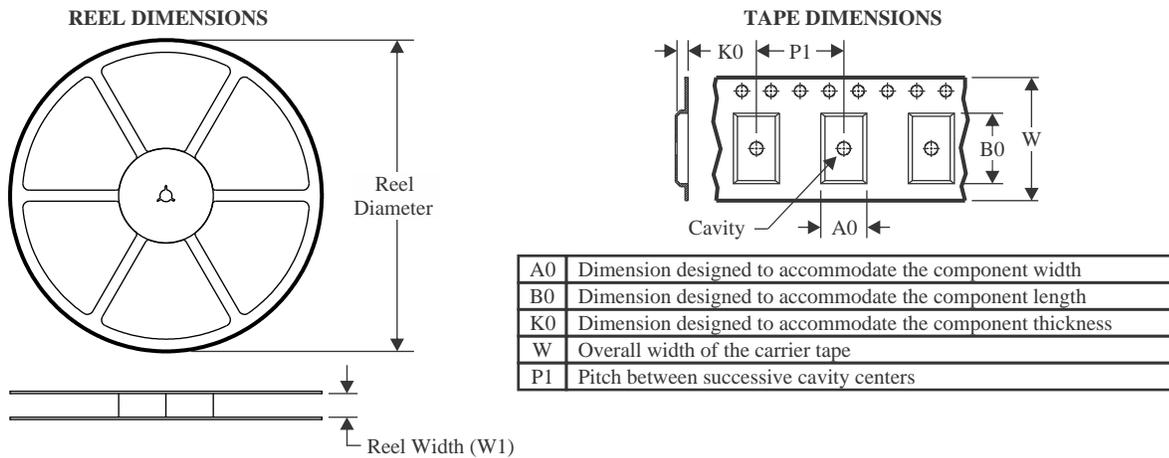
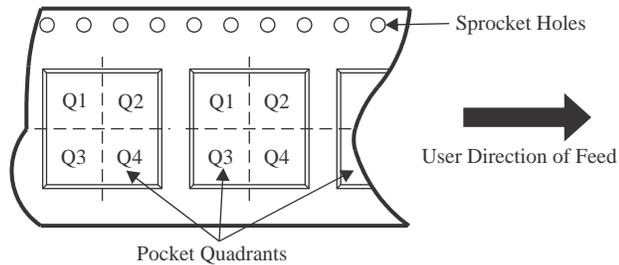
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

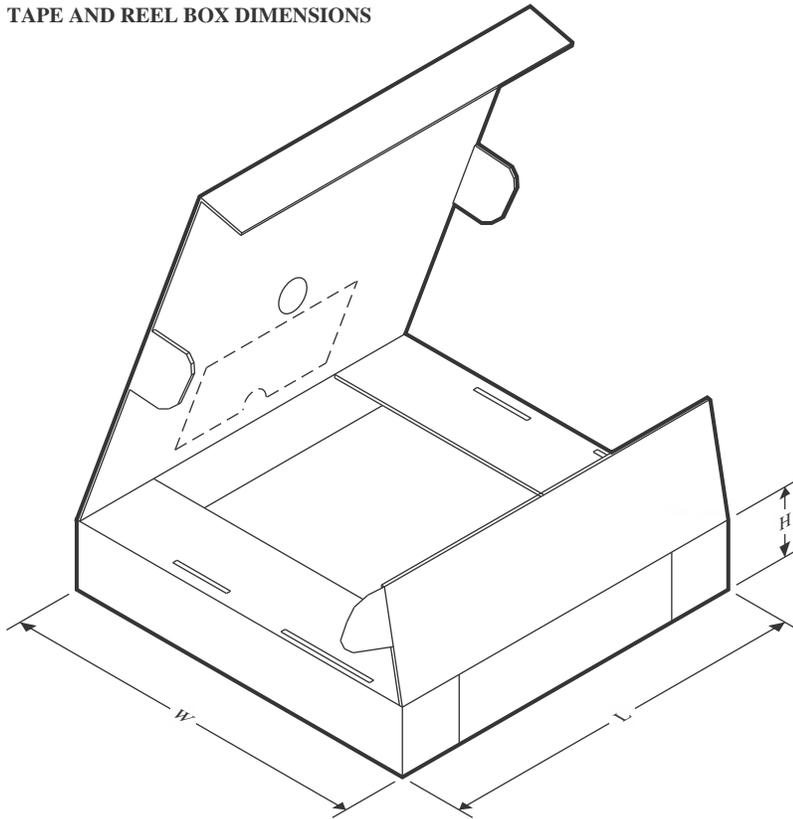
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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMX2572LPRHAR	VQFN	RHA	40	2500	330.0	16.4	6.3	6.3	1.5	12.0	16.0	Q2
LMX2572LPRHAT	VQFN	RHA	40	250	178.0	16.4	6.3	6.3	1.5	12.0	16.0	Q2

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMX2572LPRHAR	VQFN	RHA	40	2500	356.0	356.0	35.0
LMX2572LPRHAT	VQFN	RHA	40	250	208.0	191.0	35.0

## GENERIC PACKAGE VIEW

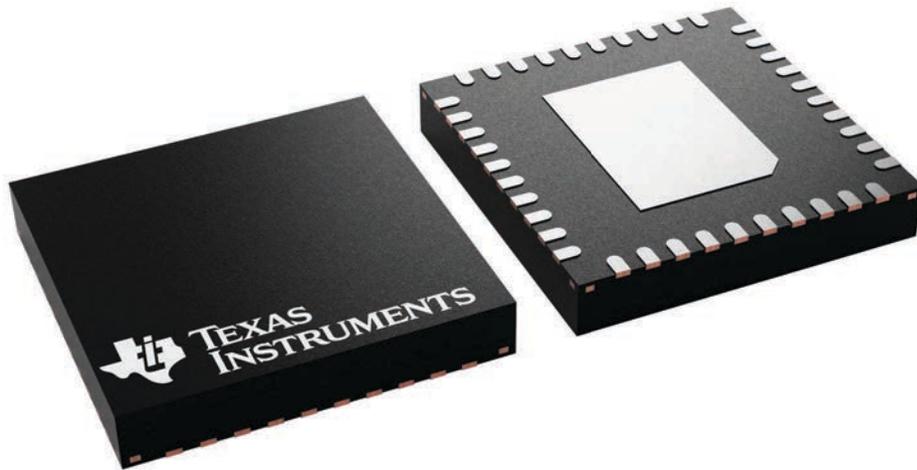
**RHA 40**

**VQFN - 1 mm max height**

6 x 6, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4225870/A

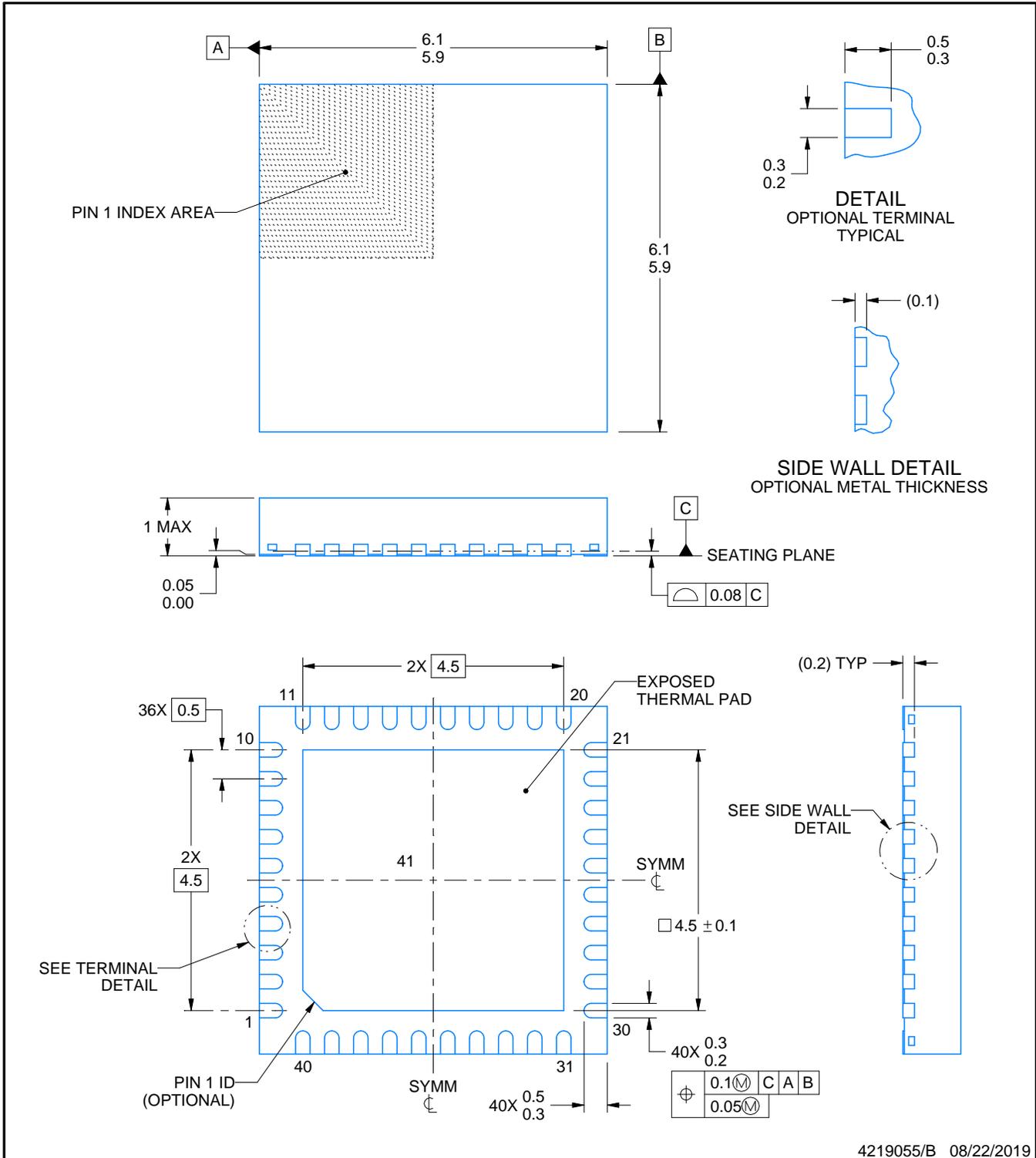
# RHA0040H



# PACKAGE OUTLINE

## VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



4219055/B 08/22/2019

**NOTES:**

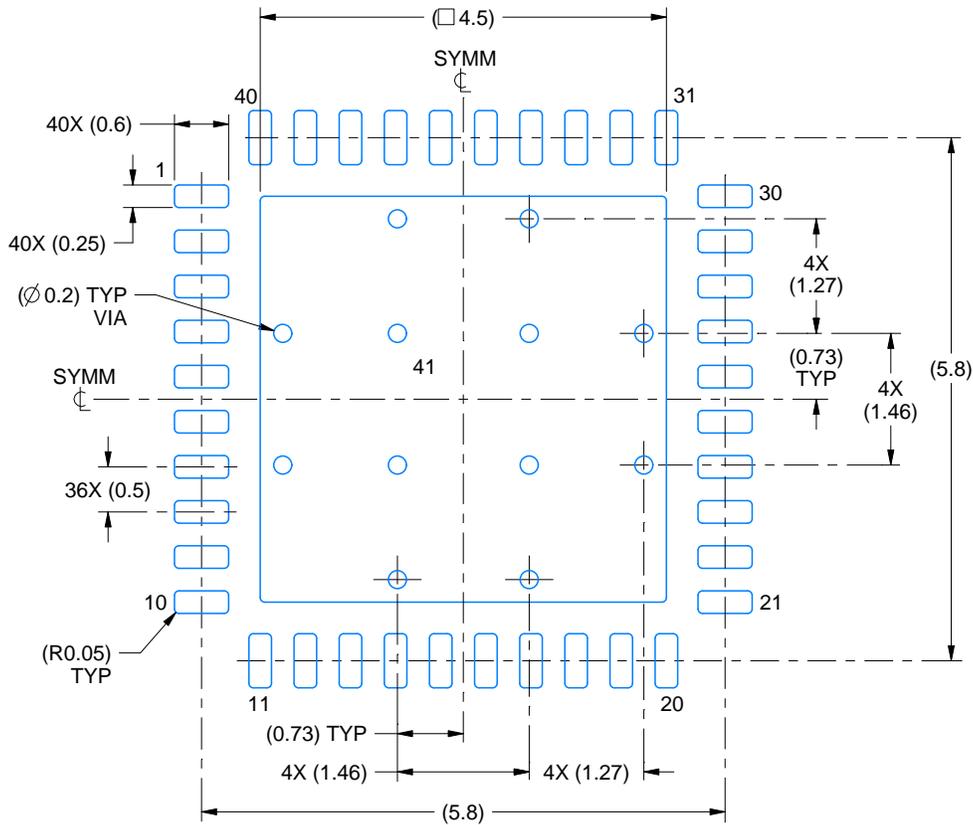
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

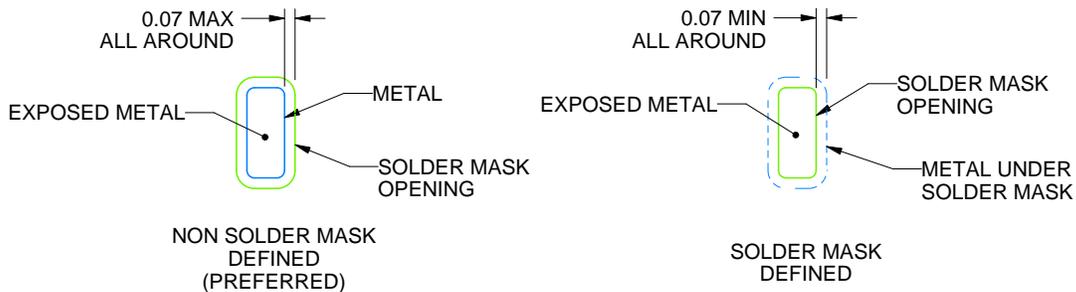
RHA0040H

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:12X



SOLDER MASK DETAILS

4219055/B 08/22/2019

NOTES: (continued)

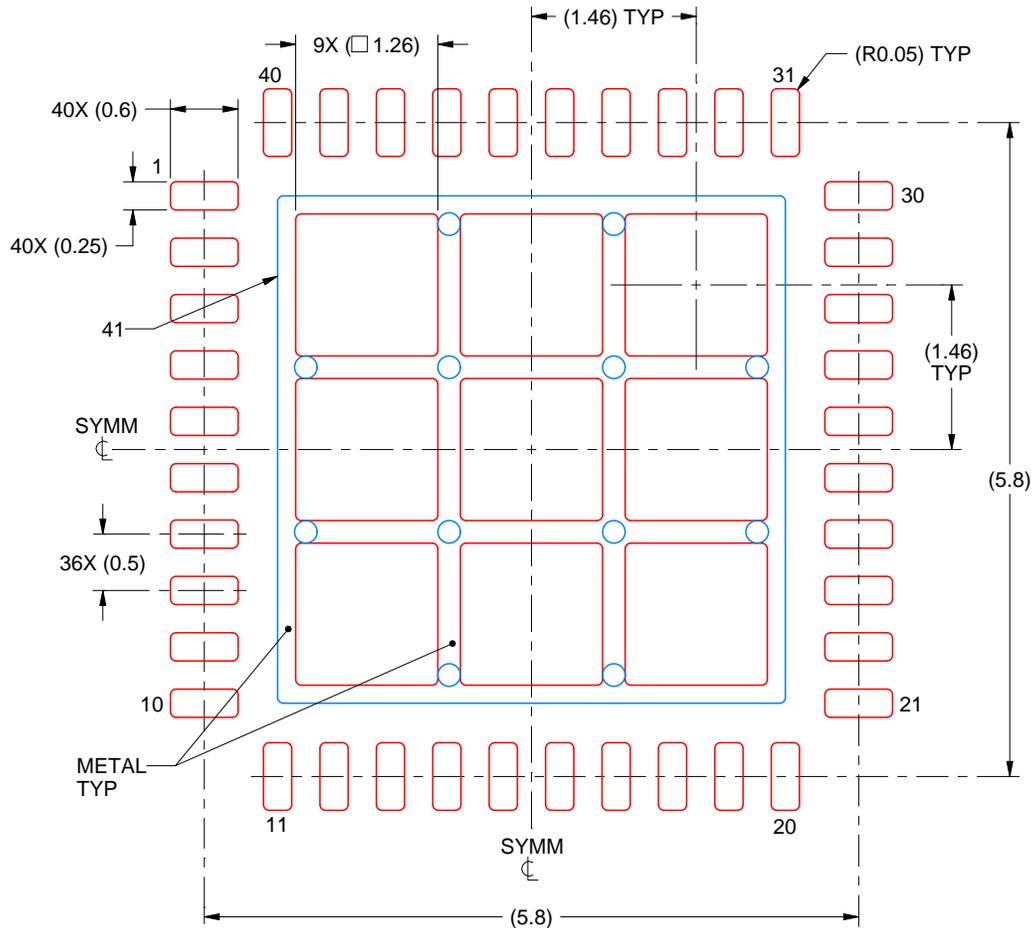
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RHA0040H

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 41:  
70% PRINTED SOLDER COVERAGE BY AREA  
SCALE:15X

4219055/B 08/22/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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